FLASH MEMORY

CMOS

32 M (4 M \times 8/2 M \times 16) BIT

MBM29LV320TE 80/90/10 MBM29LV320BE80/90/10

■ DESCRIPTION

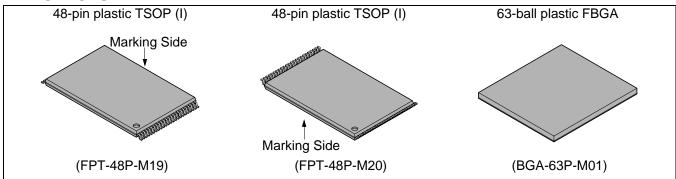
The MBM29LV320TE/BE is 32 M-bit, 3.0 V-only Flash memory organized as 4 M bytes of 8 bits each or 2 M words of 16 bits each. The device is offered in a 48-pin TSOP (I) and 63-ball FBGA packages. This device is designed to be programmed in-system with the standard system 3.0 V Vcc supply. 12.0 V Vpp and 5.0 V Vcc are not required for write or erase operations. The device can also be reprogrammed in standard EPROM programmers. The standard device offers access times 80 ns, 90 ns and 100 ns, allowing operation of high-speed microprocessors without wait state. To eliminate bus contention the device has separate chip enable $(\overline{\text{OE}})$, write enable $(\overline{\text{WE}})$ and output enable $(\overline{\text{OE}})$ controls.

(Continued)

■ PRODUCT LINE UP

| Part No. | | MBM29LV320TE/BE | | | |
|------------------------------|----------|-----------------------------------|-----|--|--|
| Fait No. | 80 | 90 | 100 | | |
| Power Supply Voltage (V) | Vcc = 3. | $Vcc = 3.0 \ V_{-0.3}^{+0.6} \ V$ | | | |
| Max Address Access Time (ns) | 80 | 90 | 100 | | |
| Max CE Access Time (ns) | 80 | 90 | 100 | | |
| Max OE Access Time (ns) | 30 | 35 | 35 | | |

■ PACKAGES





(Continued)

The device is pin and command set compatible with JEDEC standard E²PROMs. Commands are written to the command register using standard microprocessor write timings. Register contents serve as input to an internal state-machine which controls the erase and programming circuitry. Write cycles also internally latch addresses and data needed for the programming and erase operations. Reading data out of the device is similar to reading from 5.0 V and 12.0 V Flash or EPROM devices.

The device is programmed by executing the program command sequence. This will invoke the Embedded Program Algorithm which is an internal algorithm that automatically times the program pulse widths and verifies proper cell margin. Typically, each sector can be programmed and verified in about 0.5 seconds. Erase is accomplished by executing the erase command sequence. This will invoke the Embedded Erase Algorithm which is an internal algorithm that automatically preprograms the array if it is not already programmed before executing the erase operation. During erase, the device automatically time the erase pulse widths and verify proper cell margin.

A sector is typically erased and verified in 1.0 second. (If already completely preprogrammed.)

The device also features a sector erase architecture. The sector mode allows each sector to be erased and reprogrammed without affecting other sectors. The device is erased when shipped from the factory.

The device features single 3.0 V power supply operation for both read and write functions. Internally generated and regulated voltages are provided for the program and erase operations. A low Vcc detector automatically inhibits write operations on the loss of power. The end of program or erase is detected by \overline{Data} Polling of DQ_7 , by the Toggle Bit feature on DQ_6 , or the RY/ \overline{BY} output pin. Once the end of a program or erase cycle has been completed, the device internally resets to the read mode.

The device also has a hardware RESET pin. When this pin is driven low, execution of any Embedded Program Algorithm or Embedded Erase Algorithm is terminated. The internal state machine is then reset to the read mode. The RESET pin may be tied to the system reset circuitry. Therefore, if a system reset occurs during the Embedded Program Algorithm or Embedded Erase Algorithm, the device is automatically reset to the read mode and will have erroneous data stored in the address locations being programmed or erased. These locations need re-writing after the Reset. Resetting the device enables the system's microprocessor to read the boot-up firmware from the Flash memory.

Fujitsu's Flash technology combines years of EPROM and E²PROM experience to produce the highest levels of quality, reliability, and cost effectiveness. The device memory electrically erase the entire chip or all bits within a sector simultaneously via Fowler-Nordhiem tunneling. The bytes/words are programmed one byte/word at a time using the EPROM programming mechanism of hot electron injection.

■ FEATURES

- 0.23 μm Process Technology
- · Single 3.0 V read, program, and erase

Minimized system level power requirements

Compatible with JEDEC-standard commands

Use the same software commands as E2PROMs

• Compatible with JEDEC-standard world-wide pinouts

48-pin TSOP (I) (Package suffix : TN – Normal Bend Type, TR – Reversed Bend Type) 63-ball FBGA (Package suffix : PBT)

- Minimum 100,000 program/erase cycles
- High performance

80 ns maximum access time

· Sector erase architecture

Eight 4 K word and sixty-three 32 K word sectors in word mode

Eight 8 K byte and sixty-three 64 K byte sectors in byte mode

Any combination of sectors can be concurrently erased. Also supports full chip erase.

- Boot Code Sector Architecture
 - T = Top sector

B = Bottom sector

• Hidden ROM (Hi-ROM) region

256 byte of Hi-ROM, accessible through a new "Hi-ROM Enable" command sequence Factory serialized and protected to provide a secure electronic serial number (ESN)

WP/ACC input pin

At V_{IL}, allows protection of boot sectors, regardless of sector protection/unprotection status

At VIH, allows removal of boot sector protection

At Vacc, increases program performance

Embedded Erase^{™*} Algorithms

Automatically pre-programs and erases the chip or any sector

Embedded Program^{™*} Algorithms

Automatically writes and verifies data at specified address

- Data Polling and Toggle Bit feature for detection of program or erase cycle completion
- Ready/Busy output (RY/BY)

Hardware method for detection of program or erase cycle completion

Automatic sleep mode

When addresses remain stable, automatically switch themselves to low power mode.

- Low Vcc write inhibit ≤ 2.5 V
- Erase Suspend/Resume

Suspends the erase operation to allow a read data and/or program in another sector within the same device

Sector group protection

Hardware method disables any combination of sector groups from program or erase operations

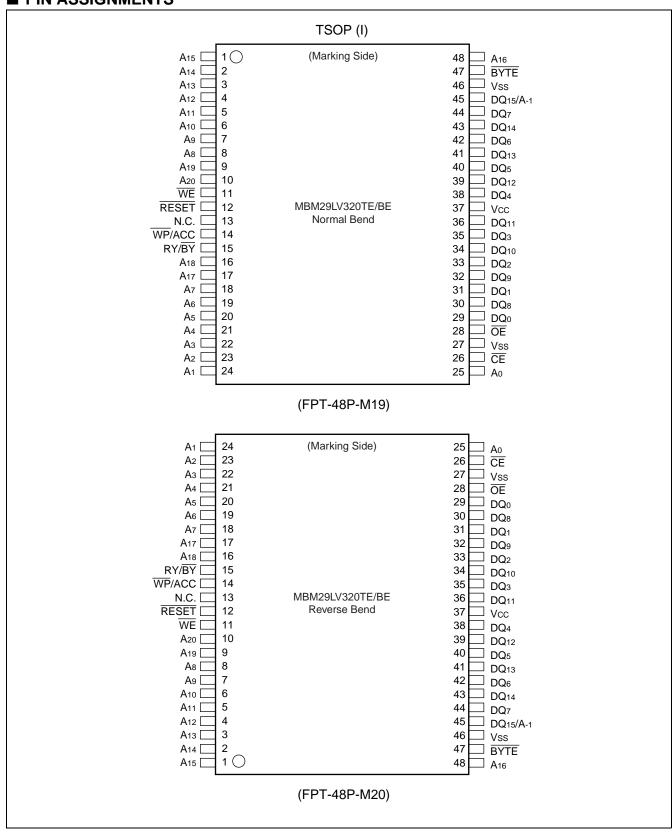
- Sector Group Protection Set function by Extended sector group protection command
- Fast Programming Function by Extended Command
- Temporary sector group unprotection

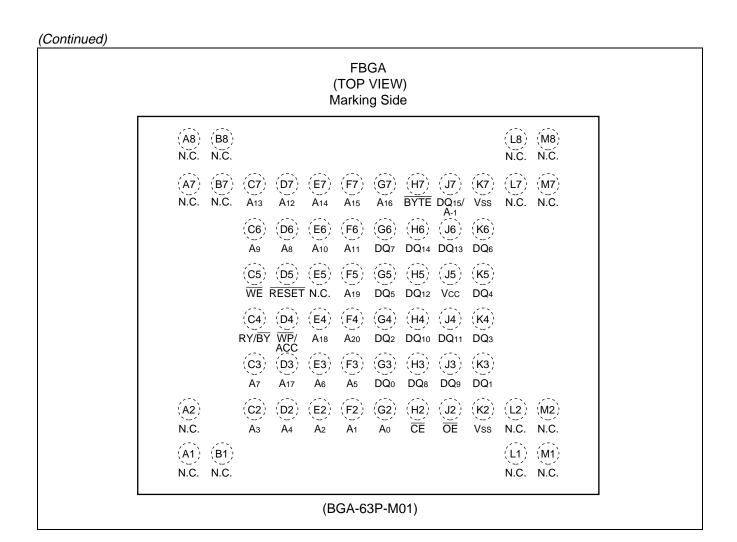
Temporary sector group unprotection via the RESET pin.

• In accordance with CFI (Common Flash Memory Interface)

^{*:} Embedded Erase™ and Embedded Program™ are trademarks of Advanced Micro Devices, Inc.

■ PIN ASSIGNMENTS



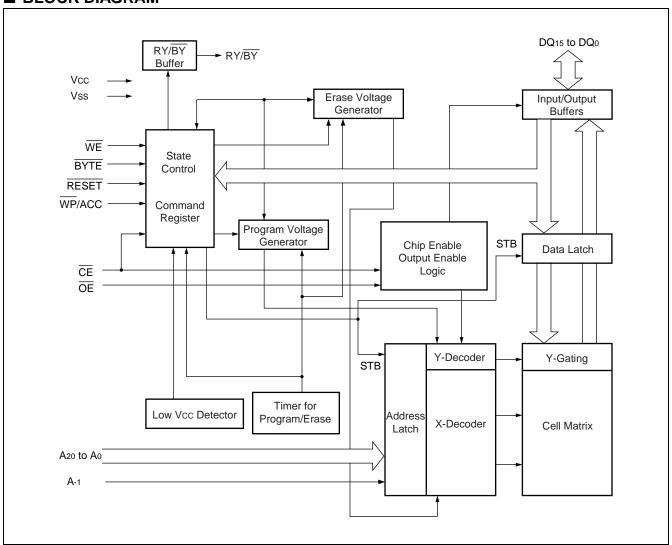


■ PIN DESCRIPTION

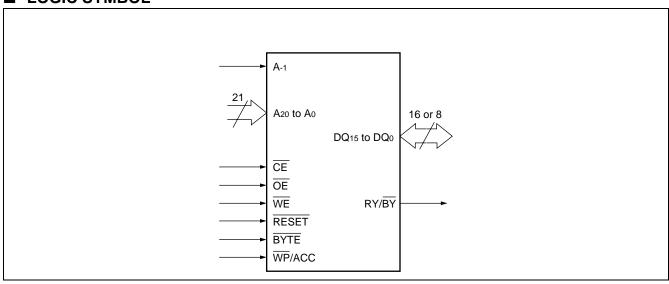
MBM29LV320 TE/BE Pin Configuration Table

| Pin | Function |
|-----------------------------------------------------|--------------------------------------------------------|
| A ₂₀ to A ₀ , A ₋₁ | Address Inputs |
| DQ ₁₅ to DQ ₀ | Data Inputs/Outputs |
| CE | Chip Enable |
| ŌĒ | Output Enable |
| WE | Write Enable |
| RY/ BY | Ready/Busy Output |
| RESET | Hardware Reset Pin/Temporary Sector Group Unprotection |
| BYTE | Selects 8-bit or 16-bit mode |
| WP/ACC | Hardware Write Protection/Program Acceleration |
| N.C. | No Internal Connection |
| Vss | Device Ground |
| Vcc | Device Power Supply |

■ BLOCK DIAGRAM



■ LOGIC SYMBOL



■ DEVICE BUS OPERATION

MBM29LV320TE/BE User Bus Operations Table (BYTE = VIH)

| Operation | CE | OE | WE | Αo | A 1 | A 6 | A 9 | DQ ₁₅ to DQ ₀ | RESET | WP/ ACC |
|----------------------------------------|----|-----|----|----------------|------------|----------------|------------|----------------------------------------|-------|------------|
| Auto-Select Manufacturer Code *1 | L | L | Н | L | L | L | VID | Code | Н | Х |
| Auto-Select Device Code *1 | L | L | Н | Н | L | L | VID | Code | Н | Х |
| Extended Auto-Select Device Code *1 | L | L | Н | Н | Н | L | VID | Code | Н | Х |
| Read *3 | L | L | Н | A ₀ | A 1 | A ₆ | A 9 | D оит | Н | Х |
| Standby | Н | Х | Х | Χ | Х | Х | Х | High-Z | Н | Х |
| Output Disable | L | Н | Н | Χ | Х | Х | Х | High-Z | Н | Х |
| Write (Program/Erase) | L | Н | L | A ₀ | A 1 | A ₆ | A 9 | Din | Н | Х |
| Enable Sector Group Protection *2, *4 | L | VID | | L | Н | L | VID | Х | Н | X *6 |
| Verify Sector Group Protection *2, *4 | L | L | Н | L | Н | L | VID | Code | Н | X *6 |
| Temporary Sector Group Unprotection *5 | Χ | Χ | Х | Χ | Х | Χ | Х | Х | VID | X *6 |
| Reset (Hardware) /Standby | Х | Х | Х | Χ | Х | Х | Χ | High-Z | L | Х |
| Boot Block Sector Write Protection | Χ | Χ | Χ | Χ | Χ | Χ | Χ | Х | Х | L |

Legend: L = V_I, H = V_I, X = V_I or V_I, □ = Pulse input. See "■DC CHARACTERISTICS" for voltage levels.

^{*1:} Manufacturer and device codes may also be accessed via a command register write sequence. See "MBM29LV320TE/BE Command Definitions Table".

^{*2:} See the section on "7. Sector Group Protection" in ■FUNCTIONAL DESCRIPTION.

^{*3:} $\overline{\text{WE}}$ can be V_{IL} if $\overline{\text{OE}}$ is V_{IL} , $\overline{\text{OE}}$ at V_{IH} initiates the write operations.

^{*4:} $Vcc = 3.3 V \pm 10\%$

^{*5:} It is also used for the extended sector group protection.

^{*6:} Conditional exceptions are to be noticed as follows: For MBM29LV320TE (SA22, 23), $\overline{\text{WP}}/\text{ACC} = V_{\text{IH}}$. For MBM29LV320BE (SA0, 1), $\overline{\text{WP}}/\text{ACC} = V_{\text{IH}}$.

MBM29LV320TE/BE User Bus Operations Table (BYTE = V⊥)

| Operation | CE | ΘE | WE | DQ ₁₅ /A ₋₁ | Ao | A 1 | A 6 | A 9 | DQ7 to DQ0 | RESET | WP/ ACC |
|----------------------------------------|----|-----|----|--------------------------------------|----------------|------------|----------------|------------|---------------|-------|------------|
| Auto-Select Manufacturer Code *1 | L | L | Н | L | L | L | L | VID | Code | Н | Х |
| Auto-Select Device Code *1 | L | L | Н | L | Н | L | L | VID | Code | Н | Х |
| Extended Auto-Select Device Code *1 | L | L | Н | L | Н | Н | L | VID | Code | Н | Х |
| Read *3 | L | L | Н | A -1 | A ₀ | A 1 | A ₆ | A 9 | D оит | Н | Х |
| Standby | Н | Х | Х | Х | Χ | Χ | Х | Х | High-Z | Н | Х |
| Output Disable | L | Н | Н | Х | Χ | Х | Х | Х | High-Z | Н | Х |
| Write (Program/Erase) | L | Н | L | A -1 | A ₀ | A 1 | A ₆ | A 9 | Din | Н | Х |
| Enable Sector Group Protection *2, *4 | L | VID | | L | L | Н | L | VID | Х | Н | X *6 |
| Verify Sector Group Protection *2, *4 | L | L | Н | L | L | Н | L | VID | Code | Н | X *6 |
| Temporary Sector Group Unprotection *5 | Х | Х | Х | Х | Χ | Х | Х | Х | Х | VID | X *6 |
| Reset (Hardware) /Standby | Χ | Х | Χ | Х | Χ | Х | Х | Χ | High-Z | L | Χ |
| Boot Block Sector Write Protection | Χ | Х | Χ | Х | Χ | Χ | Χ | Χ | Х | Х | L |

Legend: L = V_{IL}, H = V_{IH}, X = V_{IL} or V_{IH}, ¬□ = Pulse input. See "■DC CHARACTERISTICS" for voltage levels.

^{*1:} Manufacturer and device codes may also be accessed via a command register write sequence. See "MBM29LV320TE/BE Command Definitions Table".

^{*2:} See the section on "7. Sector Group Protection" in ■FUNCTIONAL DESCRIPTION.

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MBM29LV320TE/BE Command Definitions Table

| Comman Sequenc | | Bus Write Cycles | First Write | | Seco Bu Write | IS | Third Write | | Fourth Read/ Cyc | Write | Fifth Write | | Sixth Write | |
|---------------------------------|--------------|------------------------|----------------|----------|---------------------|---------|----------------|--------------|------------------------|-------|----------------|------|----------------|------|
| | | Req'd | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data |
| Read/ Reset | Word Byte | 1 | XXXh | F0h | _ | | _ | | | | _ | _ | _ | _ |
| Read/ | Word | 3 | 555h | A A I- | 2AAh | | 555h | E 01- | DA | DD | | | | |
| Reset | Byte | 3 | AAAh | AAh | 555h | 55h | AAAh | F0h | RA | RD | | | | |
| A. Hanning | Word | 3 | 555h | ۸ ۸ L | 2AAh | | 555h | 006 | | | | | | |
| Autoselect | Byte | 3 | AAAh | AAh | 555h | 55h | AAAh | 90h | | | | | | |
| Duo augus | Word | 4 | 555h | ۸ ۸ L | 2AAh | | 555h | ۸۵۶ | DΛ | DD | | | | |
| Program | Byte | 4 | AAAh | AAh | 555h | 55h | AAAh | A0h | PA | PD | | | | |
| Chin Franc | Word | _ | 555h | AAh | 2AAh | <i></i> | 555h | 80h | 555h | AAh | 2AAh | | 555h | 10h |
| Chip Erase | Byte | 6 | AAAh | AAn | 555h | 55h | AAAh | 80n | AAAh | AAn | 555h | 55h | AAAh | TUN |
| Sector | Word | _ | 555h | ۸ ۸ L | 2AAh | | 555h | 006 | 555h | A A L | 2AAh | | C 4 | 204 |
| Erase | Byte | 6 | AAAh | AAh | 555h | | AAAh | 80h | AAAh | AAh | 555h | 55h | SA | 30h |
| Erase Susper | nd | 1 | XXXh | B0h | | | | | | _ | _ | | | _ |
| Erase Resum | ne | 1 | XXXh | 30h | | | _ | _ | _ | _ | _ | _ | _ | _ |
| Set to | Word | 3 | 555h | AAh | 2AAh | 55h | 555h | 20h | | | | | | |
| Fast Mode | Byte | 3 | AAAh | AAn | 555h | 5511 | AAAh | 2011 | | | _ | | | _ |
| Fast | Word | 2 | XXXh | A0h | PA | PD | | | | | | | | |
| Program*1 | Byte | | XXXh | AUII | PA | PD | | | | | _ | | | _ |
| Reset from | Word | 2 | XXXh | 90h | XXXh | *5 | | | | | | | | |
| Fast Mode*1 | Byte | | XXXh | 9011 | XXXh | F0h | | | | | _ | | | _ |
| Extended | Word | | | | | | | | | | | | | |
| Sector Group Protection*2 | Byte | 4 | XXXh | 60h | SPA | 60h | SPA | 40h | SPA | SD | _ | _ | _ | _ |
| Query*3 | Word | 1 | 55h | 98h | | | | | | | | | | |
| Query | Byte | | AAh | 9011 | | | | | | | _ | | | _ |
| Hi-ROM | Word | 3 | 555h | AAh | 2AAh | 55h | 555h | 88h | | | | | | |
| Entry | Byte | 3 | AAAh | 77711 | 555h | 3311 | AAAh | 0011 | | | | | | |
| Hi-ROM | Word | 4 | 555h | AAh | 2AAh | 55h | 555h | A0h | (HRA) | PD | | | | |
| Program*4 | Byte | | AAAh | 7711 | 555h | 5511 | AAAh | AUII | PA | י ט | | | | |
| Hi-ROM | Word | 4 | 555h | AAh | 2AAh | 55h | 555h | 90h | XXXh | 00h | | | | |
| Exit*4 | Byte | 7 | AAAh | 7 (7 (1) | 555h | 3011 | AAAh | 3011 | 70001 | 3011 | _ | | | |

(Continued)

- *1 : This command is valid during Fast Mode.
- *2 : This command is valid while $\overline{RESET} = V_{ID}$.
- *3: The valid addresses are A₆ to A₀.
- *4: This command is valid during Hi-ROM mode.
- *5: The data "00h" is also acceptable.
- Notes: Address bits A₂₀ to A₁₁ = X = "H" or "L" for all address commands except or Program Address (PA) and Sector Address (SA) .
 - Bus operations are defined in "MBM29LV320TE/BE User Bus Operations Tables ($\overline{BYTE} = V_{IL}$)" .
 - RA = Address of the memory location to be read
 - PA = Address of the memory location to be programmed Addresses are latched on the falling edge of the write pulse.
 - SA = Address of the sector to be erased. The combination of A₂₀, A₁₉, A₁₈, A₁₇, A₁₆, A₁₅, A₁₄, A₁₃, and A₁₂ will uniquely select any sector.
 - RD = Data read from location RA during read operation.
 - PD = Data to be programmed at location PA. Data is latched on the falling edge of write pulse.
 - SPA = Sector group address to be protected. Set sector group address (SGA) and (A6, A1, A0) = (0, 1, 0).
 - SD = Sector group protection verify data. Output 01h at protected sector group addresses and output 00h at unprotected sector group addresses.
 - HRA = Address of the Hi-ROM area

29LV320TE (Top Boot Type) Word Mode: 1FFFE0h to 1FFFFh

Byte Mode: 3FFFC0h to 3FFFFFh

29LV320BE (Bottom Boot Type) Word Mode: 000000h to 000040h

Byte Mode: 000000h to 000080h

• The system should generate the following address patterns :

Word Mode: 555h or 2AAh to addresses A10 to A0

Byte Mode: AAAh or 555h to addresses A₁₀ to A₀, and A₋₁

- Both Read/Reset commands are functionally equivalent, resetting the device to the read mode.
- The command combinations not described in "MBM29LV320TE/BE Command Definition Table" are illegal.

MBM29LV320TE/BE Sector Group Protection Verify Autoselect Codes Table

| | Туре | | A ₂₀ to A ₁₂ | A 6 | A 1 | Ao | A -1 *1 | Code (HEX) |
|----------------|------------------|------|------------------------------------|------------|------------|-----|----------------|------------|
| Manufac | ture's Code | | SA | VIL | VIL | VIL | VIL | 04h |
| | MBM29LV320TE | Byte | SA | Vıl | VIL | Vih | VIL | F6h |
| Device | MBM29LV3201E | Word | SA | VIL | VIL | VIH | Х | 22F6h |
| Code | MBM29LV320BE | Byte | SA | VIL | Vıl | ViH | VIL | F9h |
| | MDMZ9LV3Z0BE | Word | SA . | VIL | VIL | VIH | Х | 22F9h |
| Extend | | Byte | | | | | VIL | 19h |
| Device Code | MBM29LV320TE/BE | Word | SA | Vıl | ViH | ViH | Х | 0019h |
| Sector G | Group Protection | | Sector Group Addresses | VıL | ViH | VIL | VIL | 01h*2 |

^{*1 :} A-1 is for Byte mode.

Expanded Autoselect Code Table

| | Туре | | Code | DQ ₁₅ | DQ ₁₄ | DQ ₁₃ | DQ ₁₂ | DQ ₁₁ | DQ ₁₀ | DQ ₉ | DQ ₈ | DQ ₇ | DQ ₆ | DQ ₅ | DQ4 | DQ ₃ | DQ ₂ | DQ ₁ | DQ₀ |
|-------------------------|---------------|-----|-------|------------------|------------------|------------------|------------------|------------------|------------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----|-----------------|-----------------|-----------------|-----|
| Manufa | cturer's Co | de | 04h | A-1/0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 |
| | MBM29LV (I | | F6h | A-1 | HZ | HZ | HZ | HZ | HZ | HZ | HZ | 1 | 1 | 1 | 1 | 0 | 1 | 1 | 0 |
| Device | 320TE | (W) | 22F6h | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | 0 |
| Code | MBM29LV | (B) | F9h | A-1 | HZ | HZ | HZ | HZ | HZ | HZ | HZ | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 1 |
| | 320BE | | 22F9h | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 1 |
| Extend | MBM29LV | (B) | 19h | A-1 | HZ | HZ | HZ | HZ | HZ | HZ | HZ | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 1 |
| Device Code | VICE 320TE/BE | | 0019h | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 1 |
| Sector Group Protection | | | 01h | A-1/0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |

(B) : Byte mode(W) : Word modeHZ: High-Z

^{*2 :} Outputs 01h at protected sector group addresses and outputs 00h at unprotected sector group addresses.

■ FLEXIBLE SECTOR-ERASE ARCHITECTURE

Sector Address Table (MBM29LV320TE)

| 0 | | | | Sec | tor / | Addr | ess | | | | Sector | (.0) | (.40) |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-----------------------------|-----------------------|------------------------|
| Sec- tor | A 20 | A 19 | A 18 | A 17 | A 16 | A 15 | A 14 | A 13 | A 12 | A 11 | Size (Kbytes/ Kwords) | (×8) Address Range | (x16) Address Range |
| SA0 | 0 | 0 | 0 | 0 | 0 | 0 | Χ | Χ | Χ | Χ | 64/32 | 000000h to 00FFFFh | 000000h to 007FFFh |
| SA1 | 0 | 0 | 0 | 0 | 0 | 1 | Х | Х | Х | Х | 64/32 | 010000h to 01FFFFh | 008000h to 00FFFFh |
| SA2 | 0 | 0 | 0 | 0 | 1 | 0 | Х | Х | Х | Х | 64/32 | 020000h to 02FFFFh | 010000h to 017FFFh |
| SA3 | 0 | 0 | 0 | 0 | 1 | 1 | Χ | Χ | Χ | Χ | 64/32 | 030000h to 03FFFFh | 018000h to 01FFFFh |
| SA4 | 0 | 0 | 0 | 1 | 0 | 0 | Х | Х | Х | Х | 64/32 | 040000h to 04FFFFh | 020000h to 027FFFh |
| SA5 | 0 | 0 | 0 | 1 | 0 | 1 | Χ | Χ | Χ | Χ | 64/32 | 050000h to 05FFFFh | 028000h to 02FFFFh |
| SA6 | 0 | 0 | 0 | 1 | 1 | 0 | Χ | Χ | Χ | Χ | 64/32 | 060000h to 06FFFFh | 030000h to 037FFFh |
| SA7 | 0 | 0 | 0 | 1 | 1 | 1 | Х | Х | Х | Х | 64/32 | 070000h to 07FFFFh | 038000h to 03FFFFh |
| SA8 | 0 | 0 | 1 | 0 | 0 | 0 | Х | Х | Х | Х | 64/32 | 080000h to 08FFFFh | 040000h to 047FFFh |
| SA9 | 0 | 0 | 1 | 0 | 0 | 1 | Х | Х | Х | Х | 64/32 | 090000h to 09FFFFh | 048000h to 04FFFFh |
| SA10 | 0 | 0 | 1 | 0 | 1 | 0 | Х | Х | Х | Х | 64/32 | 0A0000h to 0AFFFFh | 050000h to 057FFFh |
| SA11 | 0 | 0 | 1 | 0 | 1 | 1 | Х | Х | Х | Х | 64/32 | 0B0000h to 0BFFFFh | 058000h to 05FFFFh |
| SA12 | 0 | 0 | 1 | 1 | 0 | 0 | Х | Х | Х | Х | 64/32 | 0C0000h to 0CFFFFh | 060000h to 067FFFh |
| SA13 | 0 | 0 | 1 | 1 | 0 | 1 | Х | Х | Х | Х | 64/32 | 0D0000h to 0DFFFFh | 068000h to 06FFFFh |
| SA14 | 0 | 0 | 1 | 1 | 1 | 0 | Х | Х | Х | Х | 64/32 | 0E0000h to 0EFFFFh | 070000h to 077FFFh |
| SA15 | 0 | 0 | 1 | 1 | 1 | 1 | Χ | Χ | Χ | Χ | 64/32 | 0F0000h to 0FFFFh | 078000h to 07FFFFh |
| SA16 | 0 | 1 | 0 | 0 | 0 | 0 | Х | Х | Х | Х | 64/32 | 100000h to 10FFFFh | 080000h to 087FFFh |
| SA17 | 0 | 1 | 0 | 0 | 0 | 1 | Х | Х | Х | Х | 64/32 | 110000h to 11FFFFh | 088000h to 08FFFFh |
| SA18 | 0 | 1 | 0 | 0 | 1 | 0 | Χ | Χ | Χ | Χ | 64/32 | 120000h to 12FFFFh | 090000h to 097FFFh |
| SA19 | 0 | 1 | 0 | 0 | 1 | 1 | Х | Х | Х | Х | 64/32 | 130000h to 13FFFFh | 098000h to 09FFFFh |
| SA20 | 0 | 1 | 0 | 1 | 0 | 0 | Х | Х | Х | Х | 64/32 | 140000h to 14FFFFh | 0A0000h to 0A7FFFh |
| SA21 | 0 | 1 | 0 | 1 | 0 | 1 | Х | Х | Х | Х | 64/32 | 150000h to 15FFFFh | 0A8000h to 0AFFFFh |
| SA22 | 0 | 1 | 0 | 1 | 1 | 0 | Х | Х | Х | Х | 64/32 | 160000h to 16FFFFh | 0B0000h to 0B7FFFh |
| SA23 | 0 | 1 | 0 | 1 | 1 | 1 | Х | Х | Х | Х | 64/32 | 170000h to 17FFFFh | 0B8000h to 0BFFFFh |
| SA24 | 0 | 1 | 1 | 0 | 0 | 0 | Х | Х | Х | Х | 64/32 | 180000h to 18FFFFh | 0C0000h to 0C7FFFh |
| SA25 | 0 | 1 | 1 | 0 | 0 | 1 | Х | Х | Х | Х | 64/32 | 190000h to 19FFFFh | 0C8000h to 0CFFFFh |
| SA26 | 0 | 1 | 1 | 0 | 1 | 0 | Х | Х | Х | Х | 64/32 | 1A0000h to 1AFFFFh | 0D0000h to 0D7FFFh |
| SA27 | 0 | 1 | 1 | 0 | 1 | 1 | Х | Х | Х | Х | 64/32 | 1B0000h to 1BFFFFh | 0D8000h to 0DFFFFh |
| SA28 | 0 | 1 | 1 | 1 | 0 | 0 | Х | Х | Х | Х | 64/32 | 1C0000h to 1CFFFFh | 0E0000h to 0E7FFFh |
| SA29 | 0 | 1 | 1 | 1 | 0 | 1 | Х | Х | Х | Х | 64/32 | 1D0000h to 1DFFFFh | 0E8000h to 0EFFFFh |
| SA30 | 0 | 1 | 1 | 1 | 1 | 0 | Х | Х | Х | Х | 64/32 | 1E0000h to 1EFFFFh | 0F0000h to 0F7FFFh |
| SA31 | 0 | 1 | 1 | 1 | 1 | 1 | Х | Х | Х | Х | 64/32 | 1F0000h to 1FFFFFh | 0F8000h to 0FFFFFh |

| Sec- | | | | Sec | tor A | Addr | ess | | | | Sector Size | (×8) | (×16) |
|------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|---------------------|-----------------------|--------------------|
| tor | A 20 | A 19 | A 18 | A 17 | A 16 | A 15 | A 14 | A 13 | A 12 | A 11 | (Kbytes/ Kwords) | (xo) Address Range | Address Range |
| SA32 | 1 | 0 | 0 | 0 | 0 | 0 | Χ | Χ | Х | Х | 64/32 | 200000h to 20FFFFh | 100000h to 107FFFh |
| SA33 | 1 | 0 | 0 | 0 | 0 | 1 | Χ | Χ | Х | Х | 64/32 | 210000h to 21FFFFh | 108000h to 10FFFFh |
| SA34 | 1 | 0 | 0 | 0 | 1 | 0 | Х | Χ | Х | Х | 64/32 | 220000h to 22FFFFh | 110000h to 117FFFh |
| SA35 | 1 | 0 | 0 | 0 | 1 | 1 | Х | Χ | Х | Х | 64/32 | 230000h to 23FFFFh | 118000h to 11FFFFh |
| SA36 | 1 | 0 | 0 | 1 | 0 | 0 | Х | Χ | Х | Х | 64/32 | 240000h to 24FFFFh | 120000h to 127FFFh |
| SA37 | 1 | 0 | 0 | 1 | 0 | 1 | Х | Х | Х | Х | 64/32 | 250000h to 25FFFFh | 128000h to 12FFFFh |
| SA38 | 1 | 0 | 0 | 1 | 1 | 0 | Х | Х | Х | Х | 64/32 | 260000h to 26FFFFh | 130000h to 137FFFh |
| SA39 | 1 | 0 | 0 | 1 | 1 | 1 | Χ | Χ | Х | Х | 64/32 | 270000h to 27FFFFh | 138000h to 13FFFFh |
| SA40 | 1 | 0 | 1 | 0 | 0 | 0 | Х | Χ | Х | Х | 64/32 | 280000h to 28FFFFh | 140000h to 147FFFh |
| SA41 | 1 | 0 | 1 | 0 | 0 | 1 | Х | Х | Х | Х | 64/32 | 290000h to 29FFFFh | 148000h to 14FFFFh |
| SA42 | 1 | 0 | 1 | 0 | 1 | 0 | Х | Х | Х | Х | 64/32 | 2A0000h to 2AFFFFh | 150000h to 157FFFh |
| SA43 | 1 | 0 | 1 | 0 | 1 | 1 | Х | Χ | Х | Х | 64/32 | 2B0000h to 2BFFFFh | 158000h to 15FFFFh |
| SA44 | 1 | 0 | 1 | 1 | 0 | 0 | Х | Х | Х | Х | 64/32 | 2C0000h to 2CFFFFh | 160000h to 167FFFh |
| SA45 | 1 | 0 | 1 | 1 | 0 | 1 | Х | Х | Х | Х | 64/32 | 2D0000h to 2DFFFFh | 168000h to 16FFFFh |
| SA46 | 1 | 0 | 1 | 1 | 1 | 0 | Χ | Χ | Х | Х | 64/32 | 2E0000h to 2EFFFFh | 170000h to 177FFFh |
| SA47 | 1 | 0 | 1 | 1 | 1 | 1 | Х | Х | Х | Х | 64/32 | 2F0000h to 2FFFFFh | 178000h to 17FFFFh |
| SA48 | 1 | 1 | 0 | 0 | 0 | 0 | Х | Х | Х | Х | 64/32 | 300000h to 30FFFFh | 180000h to 187FFFh |
| SA49 | 1 | 1 | 0 | 0 | 0 | 1 | Χ | Χ | Х | Х | 64/32 | 310000h to 31FFFFh | 188000h to 18FFFFh |
| SA50 | 1 | 1 | 0 | 0 | 1 | 0 | Х | Χ | Х | Х | 64/32 | 320000h to 32FFFFh | 190000h to 197FFFh |
| SA51 | 1 | 1 | 0 | 0 | 1 | 1 | Х | Χ | Х | Х | 64/32 | 330000h to 33FFFFh | 198000h to 19FFFFh |
| SA52 | 1 | 1 | 0 | 1 | 0 | 0 | Х | Χ | Х | Х | 64/32 | 340000h to 34FFFFh | 1A0000h to 1A7FFFh |
| SA53 | 1 | 1 | 0 | 1 | 0 | 1 | Х | Χ | Х | Х | 64/32 | 350000h to 35FFFFh | 1A8000h to 1AFFFFh |
| SA54 | 1 | 1 | 0 | 1 | 1 | 0 | Х | Х | Х | Х | 64/32 | 360000h to 36FFFFh | 1B0000h to 1B7FFFh |
| SA55 | 1 | 1 | 0 | 1 | 1 | 1 | Х | Χ | Х | Х | 64/32 | 370000h to 37FFFFh | 1B8000h to 1BFFFFh |
| SA56 | 1 | 1 | 1 | 0 | 0 | 0 | Х | Х | Х | Х | 64/32 | 380000h to 38FFFFh | 1C0000h to 1C7FFFh |
| SA57 | 1 | 1 | 1 | 0 | 0 | 1 | Х | Χ | Х | Х | 64/32 | 390000h to 39FFFFh | 1C8000h to 1CFFFFh |
| SA58 | 1 | 1 | 1 | 0 | 1 | 0 | Х | Χ | Х | Х | 64/32 | 3A0000h to 3AFFFFh | 1D0000h to 1D7FFFh |
| SA59 | 1 | 1 | 1 | 0 | 1 | 1 | Х | Х | Х | Х | 64/32 | 3B0000h to 3BFFFFh | 1D8000h to 1DFFFFh |
| SA60 | 1 | 1 | 1 | 1 | 0 | 0 | Х | Х | Х | Х | 64/32 | 3C0000h to 3CFFFFh | 1E0000h to 1E7FFFh |
| SA61 | 1 | 1 | 1 | 1 | 0 | 1 | Х | Х | Х | Х | 64/32 | 3D0000h to 3DFFFFh | 1E8000h to 1EFFFFh |
| SA62 | 1 | 1 | 1 | 1 | 1 | 0 | Х | Х | Х | Х | 64/32 | 3E0000h to 3EFFFFh | 1F0000h to 1F7FFFh |
| SA63 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | Х | 8/4 | 3F0000h to 3F1FFFh | 1F8000h to 1F8FFFh |
| SA64 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | Х | 8/4 | 3F2000h to 3F3FFFh | 1F9000h to 1F9FFFh |

(Continued)

| Sec- | | | | Sec | tor A | Addr | ess | | | | Sector Size | (×8) | (×16) | |
|------|-------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------|-----|---------------|------|-----|---|---|---|----------------|--------------------|--------------------|--|
| tor | A 20 | $\Delta_{20} \mid_{\Delta_{40}} \mid_$ | (Kbytes/ Kwords) | ` , | Address Range | | | | | | | | | |
| SA65 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | Χ | 8/4 | 3F4000h to 3F5FFFh | 1FA000h to 1FAFFFh | |
| SA66 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | Χ | 8/4 | 3F6000h to 3F7FFFh | 1FB000h to 1FBFFFh | |
| SA67 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | Х | 8/4 | 3F8000h to 3F9FFFh | 1FC000h to 1FCFFFh | |
| SA68 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | Χ | 8/4 | 3FA000h to 3FBFFFh | 1FD000h to 1FDFFFh | |
| SA69 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | Х | 8/4 | 3FC000h to 3FDFFFh | 1FE000h to 1FEFFFh | |
| SA70 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | Х | 8/4 | 3FE000h to 3FFFFFh | 1FF000h to 1FFFFFh | |

Note : The address range is A_{20} : $A_{\text{-}1}$ if in byte mode $(\overline{BYTE}=V_{\text{IL}})$. The address range is A_{20} : A_0 if in word mode $(\overline{BYTE}=V_{\text{IH}})$.

Sector Address Table (MBM29LV320BE)

| Sec- | | | | Sec | tor A | Addr | ess | | | | Sector Size | (.40) | (.46) |
|------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|---------------------|-----------------------|------------------------|
| tor | A 20 | A 19 | A 18 | A 17 | A 16 | A 15 | A 14 | A 13 | A 12 | A 11 | (Kbytes/ Kwords) | (×8) Address Range | (×16) Address Range |
| SA70 | 1 | 1 | 1 | 1 | 1 | 1 | Х | Χ | Х | Х | 64/32 | 3F0000h to 3FFFFFh | 1F8000h to 1FFFFFh |
| SA69 | 1 | 1 | 1 | 1 | 1 | 0 | Х | Χ | Х | Х | 64/32 | 3E0000h to 3EFFFFh | 1F0000h to 1F7FFFh |
| SA68 | 1 | 1 | 1 | 1 | 0 | 1 | Х | Χ | Х | Х | 64/32 | 3D0000h to 3DFFFFh | 1E8000h to 1EFFFFh |
| SA67 | 1 | 1 | 1 | 1 | 0 | 0 | Χ | Χ | Χ | Χ | 64/32 | 3C0000h to 3CFFFFh | 1E0000h to 1E7FFFh |
| SA66 | 1 | 1 | 1 | 0 | 1 | 1 | Х | Χ | Х | Х | 64/32 | 3B0000h to 3BFFFFh | 1D8000h to 1DFFFFh |
| SA65 | 1 | 1 | 1 | 0 | 1 | 0 | Х | Χ | Х | Х | 64/32 | 3A0000h to 3AFFFFh | 1D0000h to 1D7FFFh |
| SA64 | 1 | 1 | 1 | 0 | 0 | 1 | Х | Χ | Х | Х | 64/32 | 390000h to 39FFFFh | 1C8000h to 1CFFFFh |
| SA63 | 1 | 1 | 1 | 0 | 0 | 0 | Χ | Χ | Х | Х | 64/32 | 380000h to 38FFFFh | 1C0000h to 1C7FFFh |
| SA62 | 1 | 1 | 0 | 1 | 1 | 1 | Х | Х | Х | Х | 64/32 | 370000h to 37FFFFh | 1B8000h to 1BFFFFh |
| SA61 | 1 | 1 | 0 | 1 | 1 | 0 | Х | Χ | Х | Х | 64/32 | 360000h to 36FFFFh | 1B0000h to 1B7FFFh |
| SA60 | 1 | 1 | 0 | 1 | 0 | 1 | Χ | Χ | Х | Х | 64/32 | 350000h to 35FFFFh | 1A8000h to 1AFFFFh |
| SA59 | 1 | 1 | 0 | 1 | 0 | 0 | Х | Х | Х | Х | 64/32 | 340000h to 34FFFFh | 1A0000h to 1A7FFFh |
| SA58 | 1 | 1 | 0 | 0 | 1 | 1 | Х | Х | Х | Х | 64/32 | 330000h to 33FFFFh | 198000h to 19FFFFh |
| SA57 | 1 | 1 | 0 | 0 | 1 | 0 | Χ | Χ | Х | Х | 64/32 | 320000h to 32FFFFh | 190000h to 197FFFh |
| SA56 | 1 | 1 | 0 | 0 | 0 | 1 | Χ | Χ | Х | Х | 64/32 | 310000h to 31FFFFh | 188000h to 18FFFFh |
| SA55 | 1 | 1 | 0 | 0 | 0 | 0 | Х | Х | Х | Х | 64/32 | 300000h to 30FFFFh | 180000h to 187FFFh |
| SA54 | 1 | 0 | 1 | 1 | 1 | 1 | Х | Χ | Х | Х | 64/32 | 2F0000h to 2FFFFFh | 178000h to 17FFFFh |
| SA53 | 1 | 0 | 1 | 1 | 1 | 0 | Х | Х | Х | Х | 64/32 | 2E0000h to 2EFFFFh | 170000h to 177FFFh |
| SA52 | 1 | 0 | 1 | 1 | 0 | 1 | Х | Χ | Х | Х | 64/32 | 2D0000h to 2DFFFFh | 168000h to 16FFFFh |
| SA51 | 1 | 0 | 1 | 1 | 0 | 0 | Х | Χ | Х | Х | 64/32 | 2C0000h to 2CFFFFh | 160000h to 167FFFh |
| SA50 | 1 | 0 | 1 | 0 | 1 | 1 | Х | Х | Х | Х | 64/32 | 2B0000h to 2BFFFFh | 158000h to 15FFFFh |
| SA49 | 1 | 0 | 1 | 0 | 1 | 0 | Х | Χ | Х | Х | 64/32 | 2A0000h to 2AFFFFh | 150000h to 157FFFh |
| SA48 | 1 | 0 | 1 | 0 | 0 | 1 | Х | Χ | Х | Х | 64/32 | 290000h to 29FFFFh | 148000h to 14FFFFh |
| SA47 | 1 | 0 | 1 | 0 | 0 | 0 | Χ | Χ | Х | Х | 64/32 | 280000h to 28FFFFh | 140000h to 147FFFh |
| SA46 | 1 | 0 | 0 | 1 | 1 | 1 | Χ | Χ | Х | Х | 64/32 | 270000h to 27FFFFh | 138000h to 13FFFFh |
| SA45 | 1 | 0 | 0 | 1 | 1 | 0 | Χ | Χ | Х | Х | 64/32 | 260000h to 26FFFFh | 130000h to 137FFFh |
| SA44 | 1 | 0 | 0 | 1 | 0 | 1 | Х | Χ | Х | Х | 64/32 | 250000h to 25FFFFh | 128000h to 12FFFFh |
| SA43 | 1 | 0 | 0 | 1 | 0 | 0 | Χ | Χ | Х | Х | 64/32 | 240000h to 24FFFFh | 120000h to 127FFFh |
| SA42 | 1 | 0 | 0 | 0 | 1 | 1 | Х | Х | Х | Х | 64/32 | 230000h to 23FFFFh | 118000h to 11FFFFh |
| SA41 | 1 | 0 | 0 | 0 | 1 | 0 | Х | Х | Х | Х | 64/32 | 220000h to 22FFFFh | 110000h to 117FFFh |
| SA40 | 1 | 0 | 0 | 0 | 0 | 1 | Х | Х | Х | Х | 64/32 | 210000h to 21FFFFh | 108000h to 10FFFFh |
| SA39 | 1 | 0 | 0 | 0 | 0 | 0 | Х | Х | Х | Х | 64/32 | 200000h to 20FFFFh | 100000h to 107FFFh |
| SA38 | 0 | 1 | 1 | 1 | 1 | 1 | Х | Х | Х | Х | 64/32 | 1F0000h to 1FFFFFh | 0F8000h to 0FFFFFh |

| Sec- | | | | Sec | tor A | Addr | ess | | | | Sector Size | (×8) | (×16) |
|------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|---------------------|--------------------|--------------------|
| tor | A 20 | A 19 | A 18 | A 17 | A 16 | A 15 | A 14 | A 13 | A 12 | A 11 | (Kbytes/ Kwords) | Address Range | Address Range |
| SA37 | 0 | 1 | 1 | 1 | 1 | 0 | Χ | Χ | Χ | Х | 64/32 | 1E0000h to 1EFFFFh | 0F0000h to 0F7FFh |
| SA36 | 0 | 1 | 1 | 1 | 0 | 1 | Х | Χ | Х | Х | 64/32 | 1D0000h to 1DFFFFh | 0E8000h to 0EFFFFh |
| SA35 | 0 | 1 | 1 | 1 | 0 | 0 | Х | Χ | Х | Х | 64/32 | 1C0000h to 1CFFFFh | 0E0000h to 0E7FFFh |
| SA34 | 0 | 1 | 1 | 0 | 1 | 1 | Х | Χ | Х | Х | 64/32 | 1B0000h to 1BFFFFh | 0D8000h to 0DFFFFh |
| SA33 | 0 | 1 | 1 | 0 | 1 | 0 | Х | Χ | Х | Х | 64/32 | 1A0000h to 1AFFFFh | 0D0000h to 0D7FFFh |
| SA32 | 0 | 1 | 1 | 0 | 0 | 1 | Х | Х | Х | Х | 64/32 | 190000h to 19FFFFh | 0C8000h to 0CFFFFh |
| SA31 | 0 | 1 | 1 | 0 | 0 | 0 | Х | Χ | Х | Х | 64/32 | 180000h to 18FFFFh | 0C0000h to 0C7FFFh |
| SA30 | 0 | 1 | 0 | 1 | 1 | 1 | Х | Χ | Х | Х | 64/32 | 170000h to 17FFFFh | 0B8000h to 0BFFFFh |
| SA29 | 0 | 1 | 0 | 1 | 1 | 0 | Х | Х | Х | Х | 64/32 | 160000h to 16FFFFh | 0B0000h to 0B7FFFh |
| SA28 | 0 | 1 | 0 | 1 | 0 | 1 | Х | Χ | Х | Х | 64/32 | 150000h to 15FFFFh | 0A8000h to 0AFFFFh |
| SA27 | 0 | 1 | 0 | 1 | 0 | 0 | Х | Χ | Х | Х | 64/32 | 140000h to 14FFFFh | 0A0000h to 0A7FFFh |
| SA26 | 0 | 1 | 0 | 0 | 1 | 1 | Х | Χ | Х | Х | 64/32 | 130000h to 13FFFFh | 098000h to 09FFFFh |
| SA25 | 0 | 1 | 0 | 0 | 1 | 0 | Х | Χ | Х | Х | 64/32 | 120000h to 12FFFFh | 090000h to 097FFFh |
| SA24 | 0 | 1 | 0 | 0 | 0 | 1 | Х | Χ | Х | Х | 64/32 | 110000h to 11FFFFh | 088000h to 08FFFFh |
| SA23 | 0 | 1 | 0 | 0 | 0 | 0 | Х | Х | Х | Х | 64/32 | 100000h to 10FFFFh | 080000h to 087FFFh |
| SA22 | 0 | 0 | 1 | 1 | 1 | 1 | Х | Χ | Х | Х | 64/32 | 0F0000h to 0FFFFh | 078000h to 07FFFFh |
| SA21 | 0 | 0 | 1 | 1 | 1 | 0 | Х | Χ | Х | Х | 64/32 | 0E0000h to 0EFFFFh | 070000h to 077FFFh |
| SA20 | 0 | 0 | 1 | 1 | 0 | 1 | Х | Х | Х | Х | 64/32 | 0D0000h to 0DFFFFh | 068000h to 06FFFFh |
| SA19 | 0 | 0 | 1 | 1 | 0 | 0 | Х | Χ | Х | Х | 64/32 | 0C0000h to 0CFFFFh | 060000h to 067FFFh |
| SA18 | 0 | 0 | 1 | 0 | 1 | 1 | Х | Χ | Х | Х | 64/32 | 0B0000h to 0BFFFFh | 058000h to 05FFFFh |
| SA17 | 0 | 0 | 1 | 0 | 1 | 0 | Х | Х | Х | Х | 64/32 | 0A0000h to 0AFFFFh | 050000h to 057FFFh |
| SA16 | 0 | 0 | 1 | 0 | 0 | 1 | Х | Χ | Х | Х | 64/32 | 090000h to 09FFFFh | 048000h to 04FFFFh |
| SA15 | 0 | 0 | 1 | 0 | 0 | 0 | Χ | Χ | Χ | Χ | 64/32 | 080000h to 08FFFFh | 040000h to 047FFFh |
| SA14 | 0 | 0 | 0 | 1 | 1 | 1 | Χ | Χ | Χ | Χ | 64/32 | 070000h to 07FFFFh | 038000h to 03FFFFh |
| SA13 | 0 | 0 | 0 | 1 | 1 | 0 | Х | Χ | Х | Х | 64/32 | 060000h to 06FFFFh | 030000h to 037FFFh |
| SA12 | 0 | 0 | 0 | 1 | 0 | 1 | Х | Χ | Х | Х | 64/32 | 050000h to 05FFFFh | 028000h to 02FFFFh |
| SA11 | 0 | 0 | 0 | 1 | 0 | 0 | Х | Х | Х | Х | 64/32 | 040000h to 04FFFFh | 020000h to 027FFFh |
| SA10 | 0 | 0 | 0 | 0 | 1 | 1 | Х | Χ | Х | Х | 64/32 | 030000h to 03FFFFh | 018000h to 01FFFFh |
| SA9 | 0 | 0 | 0 | 0 | 1 | 0 | Х | Χ | Х | Х | 64/32 | 020000h to 02FFFFh | 010000h to 017FFFh |
| SA8 | 0 | 0 | 0 | 0 | 0 | 1 | Х | Χ | Х | Х | 64/32 | 010000h to 01FFFFh | 008000h to 00FFFFh |
| SA7 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | Х | 8/4 | 00E000h to 00FFFFh | 007000h to 007FFFh |
| SA6 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | Х | 8/4 | 00C000h to 00DFFFh | 006000h to 006FFFh |
| SA5 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | Х | 8/4 | 00A000h to 00BFFFh | 005000h to 005FFFh |

(Continued)

| Sec- | | Sector Address | | | | | | | | | Sector Size | (×8) | (×16) |
|------|-------------|----------------|-------------|-------------|-------------|-------------|-------------|-------------|-----------------------------------------|---|---------------------|--------------------|--------------------|
| tor | A 20 | A 19 | A 18 | A 17 | A 16 | A 15 | A 14 | A 13 | Δ ₁₃ Δ ₁₄ (Kbytes | | (Kbytes/ Kwords) | Address Range | Address Range |
| SA4 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | Χ | 8/4 | 008000h to 009FFFh | 004000h to 004FFFh |
| SA3 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | Х | 8/4 | 006000h to 007FFFh | 003000h to 003FFFh |
| SA2 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | Х | 8/4 | 004000h to 005FFFh | 002000h to 002FFFh |
| SA1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | Х | 8/4 | 002000h to 003FFFh | 001000h to 001FFFh |
| SA0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | Х | 8/4 | 000000h to 001FFFh | 000000h to 000FFFh |

Note : The address range is A_{20} : A_{-1} if in byte mode ($\overline{BYTE} = V_{IL}$) . The address range is A_{20} : A_0 if in word mode ($\overline{BYTE} = V_{IH}$) .

Sector Group Address Table (MBM29LV320TE) (Top Boot Block)

| Sector Group | A 20 | A 19 | A 18 | A 17 | A 16 | A 15 | A 14 | A 13 | A 12 | Sectors |
|--------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|--------------|
| SGA0 | 0 | 0 | 0 | 0 | Х | Х | Х | Х | Х | SA0 to SA3 |
| SGA1 | 0 | 0 | 0 | 1 | Х | Х | Х | Х | Х | SA4 to SA7 |
| SGA2 | 0 | 0 | 1 | 0 | Х | Х | Х | Х | Х | SA8 to SA11 |
| SGA3 | 0 | 0 | 1 | 1 | Х | Х | Х | Х | Х | SA12 to SA15 |
| SGA4 | 0 | 1 | 0 | 0 | Х | Х | Х | Х | Х | SA16 to SA19 |
| SGA5 | 0 | 1 | 0 | 1 | Х | Х | Х | Х | Х | SA20 to SA23 |
| SGA6 | 0 | 1 | 1 | 0 | Х | Х | Х | Х | Х | SA24 to SA27 |
| SGA7 | 0 | 1 | 1 | 1 | Х | Х | Х | Х | Х | SA28 to SA31 |
| SGA8 | 1 | 0 | 0 | 0 | Х | Х | Х | Х | Х | SA32 to SA35 |
| SGA9 | 1 | 0 | 0 | 1 | Х | Х | Х | Х | Х | SA36 to SA39 |
| SGA10 | 1 | 0 | 1 | 0 | Х | Х | Х | Х | Х | SA40 to SA43 |
| SGA11 | 1 | 0 | 1 | 1 | Х | Х | Х | Х | Х | SA44 to SA47 |
| SGA12 | 1 | 1 | 0 | 0 | Х | Х | Х | Х | Х | SA48 to SA51 |
| SGA13 | 1 | 1 | 0 | 1 | Х | Х | Х | Х | Х | SA52 to SA55 |
| SGA14 | 1 | 1 | 1 | 0 | Х | Х | Х | Х | Х | SA56 to SA59 |
| | | | | | 0 | 0 | | | | |
| SGA15 | 1 | 1 | 1 | 1 | 0 | 1 | Х | X | Х | SA60 to SA62 |
| | | | | | 1 | 0 | | | | |
| SGA16 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | SA63 |
| SGA17 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | SA64 |
| SGA18 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | SA65 |
| SGA19 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | SA66 |
| SGA20 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | SA67 |
| SGA21 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | SA68 |
| SGA22 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | SA69 |
| SGA23 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | SA70 |

Sector Group Address Table (MBM29LV320BE) (Bottom Boot Block)

| Sector Group | A 20 | A 19 | A 18 | A 17 | A 16 | A 15 | A 14 | A 13 | A 12 | Sectors |
|--------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|--------------|
| SGA0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | SA0 |
| SGA1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | SA1 |
| SGA2 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | SA2 |
| SGA3 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | SA3 |
| SGA4 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | SA4 |
| SGA5 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | SA5 |
| SGA6 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | SA6 |
| SGA7 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | SA7 |
| | | | | | 0 | 1 | | | | |
| SGA8 | 0 | 0 | 0 | 0 | 1 | 0 | Х | Х | Х | SA8 to SA10 |
| | | | | | 1 | 1 | | | | |
| SGA9 | 0 | 0 | 0 | 1 | Х | Х | Х | Х | Х | SA11 to SA14 |
| SGA10 | 0 | 0 | 1 | 0 | Х | Х | Х | Х | Х | SA15 to SA18 |
| SGA11 | 0 | 0 | 1 | 1 | Х | Х | Х | Х | Х | SA19 to SA22 |
| SGA12 | 0 | 1 | 0 | 0 | Х | Х | Х | Х | Х | SA23 to SA26 |
| SGA13 | 0 | 1 | 0 | 1 | Х | Х | Х | Х | Х | SA27 to SA30 |
| SGA14 | 0 | 1 | 1 | 0 | Х | Х | Х | Х | Х | SA31 to SA34 |
| SGA15 | 0 | 1 | 1 | 1 | Х | Х | Х | Х | Х | SA35 to SA38 |
| SGA16 | 1 | 0 | 0 | 0 | Х | Х | Х | Х | Х | SA39 to SA42 |
| SGA17 | 1 | 0 | 0 | 1 | Х | Х | Х | Х | Х | SA43 to SA46 |
| SGA18 | 1 | 0 | 1 | 0 | Х | Х | Х | Х | Х | SA47 to SA50 |
| SGA19 | 1 | 0 | 1 | 1 | Х | Х | Х | Х | Х | SA51 to SA54 |
| SGA20 | 1 | 1 | 0 | 0 | Х | Х | Х | Х | Х | SA55 to SA58 |
| SGA21 | 1 | 1 | 0 | 1 | Х | Х | Х | Х | Х | SA59 to SA62 |
| SGA22 | 1 | 1 | 1 | 0 | Х | Х | Х | Х | Х | SA63 to SA66 |
| SGA23 | 1 | 1 | 1 | 1 | Х | Х | Х | Х | Х | SA67 to SA70 |

Common Flash Memory Interface Code Table

| Description | A ₆ to A ₀ | DQ ₁₅ to DQ ₀ |
|--------------------------------------------------------------------------------------|----------------------------------|-------------------------------------|
| Query-unique ASCII string "QRY" | 10h 11h 12h | 0051h 0052h 0059h |
| Primary OEM Command Set 02h : AMD/FJ standard type | 13h 14h | 0002h 0000h |
| Address for Primary Extended Table | 15h 16h | 0040h 0000h |
| Alternate OEM Command Set (00h = not applicable) | 17h 18h | 0000h 0000h |
| Address for Alternate OEM Extended Table | 19h 1Ah | 0000h 0000h |
| V_{CC} Min (write/erase) DQ_7 to DQ_4 : 1 V/bit, DQ_3 to DQ_0 : 100 mV/bit | 1Bh | 0027h |
| Vcc Max (write/erase) DQ₂ to DQ₄ : 1 V/bit, DQ₃ to DQ₀ : 100 mV/bit | 1Ch | 0036h |
| V _{PP} Min voltage | 1Dh | 0000h |
| V _{PP} Max voltage | 1Eh | 0000h |
| Typical timeout per single byte/word write 2 ^N μs | 1Fh | 0004h |
| Typical timeout for Min size buffer write 2 ^N μs | 20h | 0000h |
| Typical timeout per individual block erase 2 ^N ms | 21h | 000Ah |
| Typical timeout for full chip erase 2 ^N ms | 22h | 0000h |
| Max timeout for byte/word write 2 ^N times typical | 23h | 0005h |
| Max timeout for buffer write 2 ^N times typical | 24h | 0000h |
| Max timeout per individual block erase 2 ^N times typical | 25h | 0004h |
| Max timeout for full chip erase 2 ^N times typical | 26h | 0000h |
| Device Size = 2 ^N byte | 27h | 0016h |
| Flash Device Interface description | 28h 29h | 0002h 0000h |
| Max number of byte in multi-byte write = 2^N | 2Ah 2Bh | 0000h 0000h |
| Number of Erase Block Regions within device | 2Ch | 0002h |
| Erase Block Region 1 Information | 2Dh 2Eh 2Fh 30h | 0007h 0000h 0020h 0000h |
| Erase Block Region 2 Information | 31h 32h 33h 34h | 003Eh 0000h 0000h 0001h |

| Description | A ₆ to A ₀ | DQ ₁₅ to DQ ₀ |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------|-------------------------------------|
| Query-unique ASCII string "PRI" | 40h 41h 42h | 0050h 0052h 0049h |
| Major version number, ASCII | 43h | 0031h |
| Minor version number, ASCII | 44h | 0031h |
| Address Sensitive Unlock 00h = Required 01h = Not Required | 45h | 0000h |
| Erase Suspend 00h = Not Supported 01h = To Read Only 02h = To Read & Write | 46h | 0002h |
| Sector Group Protection 00h = Not Supported X = Number of sectors in per group | 47h | 0004h |
| Sector Group Temporary Unprotection 00h = Not Supported 01h = Supported | 48h | 0001h |
| Sector Group Protection Algorithm | 49h | 0004h |
| Number of Sector for Bank 2 00h = Not Supported | 4Ah | 0000h |
| Burst Mode Type 00h = Not Supported | 4Bh | 0000h |
| Page Mode Type 00h = Not Supported | 4Ch | 0000h |
| V _{ACC} (Acceleration) Supply Minimum 00h = Not Supported, DQ ₇ to DQ ₄ : 1 V/bit, DQ ₃ to DQ ₀ : 100 mV/bit | 4Dh | 00B5h |
| V _{ACC} (Acceleration) Supply Maximum 00h = Not Supported, DQ ₇ to DQ ₄ : 1 V/bit, DQ ₃ to DQ ₀ : 100 mV/bit | 4Eh | 00C5h |
| Boot Type 02h = MBM29LV320BE 03h = MBM29LV320TE | 4Fh | 00XXh |

■ FUNCTIONAL DESCRIPTION

1. Read Mode

The device has two control functions which must be satisfied in order to obtain data at the outputs. \overline{CE} is the power control and should be used for a device selection. \overline{OE} is the output control and should be used to gate data to the output pins if a device is selected.

Address access time (t_{ACC}) is equal to delay from stable addresses to valid output data. The chip enable access time (t_{CE}) is the delay from stable addresses and stable \overline{CE} to valid data at the output pins. The output enable access time is the delay from the falling edge of \overline{OE} to valid data at the output pins. (Assuming the addresses have been stable for at least t_{ACC} - t_{OE} time.) When reading out data without changing addresses after power-up, it is necessary to input hardware reset or to change \overline{CE} pin from "H" or "L".

2. Standby Mode

There are two ways to implement the standby mode on the device, one using both the $\overline{\text{CE}}$ and $\overline{\text{RESET}}$ pins; the other via the $\overline{\text{RESET}}$ pin only.

When using both pins, a CMOS standby mode is achieved with $\overline{\text{CE}}$ and $\overline{\text{RESET}}$ inputs both held at $V\text{cc} \pm 0.3 \text{ V}$. Under this condition the current consumed is less than 5 μ A Max During Embedded Algorithm operation, Vcc active current (Icc2) is required even $\overline{\text{CE}}$ = "H". The device can be read with standard access time (tce) from either of these standby modes.

When using the $\overline{\text{RESET}}$ pin only, a CMOS standby mode is achieved with $\overline{\text{RESET}}$ input held at $V_{SS} \pm 0.3 \text{ V}$ ($\overline{\text{CE}}$ = "H" or "L") . Under this condition the current consumed is less than 5 μ A Max Once the $\overline{\text{RESET}}$ pin is taken high, the device requires I_{RH} as wake up time for outputs to be valid for read access.

In the standby mode the outputs are in the high impedance state, independently of the $\overline{\text{OE}}$ input.

3. Automatic Sleep Mode

There is a function called automatic sleep mode to restrain power consumption during read-out of the device data. This mode can be useful in the application such as a handy terminal which requires low power consumption.

To activate this mode, the device automatically switches themselves to low power mode when the device addresses remain stable during access time of 150 ns. It is not necessary to control \overline{CE} , \overline{WE} , and \overline{OE} on the mode. Under the mode, the current consumed is typically 1 μ A (CMOS Level) .

During simultaneous operation, Vcc active current (Icc2) is required.

Since the data are latched during this mode, the data are read-out continuously. If the addresses are changed, the mode is canceled automatically, and the device read the data for changed addresses.

4. Output Disable

With the $\overline{\text{OE}}$ input at a logic high level (V_{IH}), output from the device is disabled. This will cause the output pins to be in a high impedance state.

5. Autoselect

The autoselect mode allows the reading out of a binary code from the device and will identify its manufacturer and type. This mode is intended for use by programming equipment for the purpose of automatically matching the device to be programmed with its corresponding programming algorithm. This mode is functional over the entire temperature range of the device.

To activate this mode, the programming equipment must force V_{ID} (11.5 V to 12.5 V) on address pin A_9 . Two identifier bytes may then be sequenced from the device outputs by toggling address A_0 from V_{IL} to V_{IH} . All addresses are DON'T CARES except A_6 , A_1 , and A_0 (A_{-1}). (See "MBM29LV320TE/BE User Bus Operations Tables (BYTE = V_{IH} and BYTE = V_{IL})" in \blacksquare DEVICE BUS OPERATIONS.)

The manufacturer and device codes may also be read via the command register, for instances when the device is erased or programmed in a system without access to high voltage on the A₃ pin. The command sequence is illustrated in "MBM29LV320TE/BE Command Definitions Table" (■DEVICE BUS OPERATIONS) (See "2. Autoselect Command" in ■COMAND DIFINITIONS).

Word 0 ($A_0 = V_{IL}$) represents the manufacturer's code (Fujitsu = 04h) and word 1 ($A_0 = V_{IH}$) represents the device identifier code. Word 3 ($A_1 = A_0 = V_{IH}$) represents the extended device code. These three bytes/words are given in "MBM29LV320TE/BE Sector Group Protection Verify Autoselect Codes Table" and "Expanded Autoselect Code Table" (\blacksquare DEVICE BUS OPERATIONS) . In order to read the proper device codes when executing the autoselect, A_1 must be V_{IL} . (See "MBM29LV320TE/BE Sector Group Protection Verify Autoselect Codes Table" and "Expanded Autoselect Code Table" in \blacksquare DEVICE BUS OPERATIONS.)

6. Write

The device erasure and programming are accomplished via the command register. The contents of the register serve as inputs to the internal state machine. The state machine outputs dictate the function of the device.

The command register itself does not occupy any addressable memory location. The register is a latch used to store the commands, along with the address and data information needed to execute the command. The command register is written by bringing \overline{WE} to V_{IL} , while \overline{CE} is at V_{IL} and \overline{OE} is at V_{IH} . Addresses are latched on the falling edge of \overline{WE} or \overline{CE} , whichever happens later; while data is latched on the rising edge of \overline{WE} or \overline{CE} , whichever happens first. Standard microprocessor write timings are used.

See "Read Only Operation Characteristics" in ■AC CHARACTERISTICS for specific timing parameters.

7. Sector Group Protection

The device features hardware sector group protection. This feature will disable both program and erase operations in any combination of twenty five sector groups of memory. (See "Sector Group Address Tables (MBM29LV320TE/BE)" in FLEXIBLE SECTOR-ERASE ARCHITECTURE). The sector group protection feature is enabled using programming equipment at the user's site. The device is shipped with all sector groups unprotected.

To activate this mode, the programming equipment must force V_{ID} on address pin A_9 and control pin \overline{OE} , (suggest $V_{ID} = 11.5 \text{ V}$), $\overline{CE} = V_{IL}$ and $A_6 = A_0 = V_{IL}$, $A_1 = V_{IH}$. The sector group addresses (A_{20} , A_{19} , A_{18} , A_{17} , A_{16} , A_{15} , A_{14} , A_{13} , and A_{12}) should be set to the sector to be protected. "Sector Address Tables (MBM29LV320TE/BE)" in FLEXIBLE SECTOR-ERASE ARCHITECTURE define the sector address for each of the seventy one (71) individual sectors, and "Sector Group Address Tables (MBM29LV320TE/BE)" in FLEXIBLE SECTOR-ERASE ARCHITECTURE define the sector group address for each of the twenty five (25) individual group sectors. Programming of the protection circuitry begins on the falling edge of the \overline{WE} pulse and is terminated with the rising edge of the same. Sector group addresses must be held constant during the \overline{WE} pulse. See "14. Sector Group Protection Timing Diagram" in TIMING DIAGRAM and "5. Sector Group Protection Algorithm" in FLOW CHART for sector group protection waveforms and algorithm.

To verify programming of the protection circuitry, the programming equipment must force V_{ID} on address pin A_9 with \overline{CE} and \overline{OE} at V_{IL} and \overline{WE} at V_{IH} . Scanning the sector group addresses (A_{20} , A_{19} , A_{18} , A_{17} , A_{16} , A_{15} , A_{14} , A_{13} , and A_{12}) while (A_6 , A_1 , A_0) = (0, 1, 0) will produce a logical "1" code at device output DQ $_0$ for a protected sector. Otherwise the device will produce "0" for unprotected sector. In this mode, the lower order addresses, except for A_0 , A_1 , and A_6 are DON'T CARES. Address locations with $A_1 = V_{IL}$ are reserved for Autoselect manufacturer and device codes. A_{-1} requires to apply to V_{IL} on byte mode.

8. Temporary Sector Group Unprotection

This feature allows temporary unprotection of previously protected sector groups of the device in order to change data. The Sector Group Unprotection mode is activated by setting the RESET pin to high voltage (V_{ID}). During this mode, formerly protected sector groups can be programmed or erased by selecting the sector group addresses. Once the V_{ID} is taken away from the RESET pin, all the previously protected sector groups will be protected again. See "15. Temporary Sector Group Unprotection Timing Diagram" in ■TIMING DIAGRAM and "6. Temporary Sector Group Unprotection Algorithm" in ■FLOW CHART.

9. Extended Sector Group Protection

10. RESET

Hardware Reset

The device may be reset by driving the RESET pin to V_{IL}. The RESET pin has a pulse requirement and has to be kept low (V_{IL}) for at least "t_{RP}" in order to properly reset the internal state machine. Any operation in the process of being executed will be terminated and the internal state machine will be reset to the read mode "t_{READY}" after the RESET pin is driven low. Furthermore, once the RESET pin goes high, the device requires an additional "t_{RH}" before it will allow read access. When the RESET pin is low, the device will be in the standby mode for the duration of the pulse and all the data output pins will be tri-stated. If a hardware reset occurs during a program or erase operation, the data at that particular location will be corrupted. Please note that the RY/BY output signal should be ignored during the RESET pulse. See "10. RESET, RY/BY Timing Diagram" in ■TIMING DIAGRAM for the timing diagram. See "8. Temporary Sector Group Unprotection" for additional functionality.

11. Boot Block Sector Protection

The Write Protection function provides a hardware method of protecting certain boot sectors without using V_{ID} . This function is one of two provided by the \overline{WP}/ACC pin.

If the system asserts $V_{\text{\tiny IL}}$ on the $\overline{\text{WP}}/\text{ACC}$ pin, the device disables program and erase functions in the two "outermost" 8 K byte boot sectors independently of whether those sectors are protected or unprotected using the method described in "Sector Protection/Unprotection". The two outermost 8 K byte boot sectors are the two sectors containing the lowest addresses in a bottom-boot-configured device, or the two sectors containing the highest addresses in a top-boot-congfigured device.

(MBM29LV320TE: SA69 and SA70, MBM29LV320BE: SA0 and SA1)

If the system asserts V_H on the \overline{WP}/ACC pin, the device reverts to whether the two outermost 8 K byte boot sectors were last set to be protected or unprotected. That is, sector protection or unprotection for these two sectors depends on whether they were last protected or unprotected using the method described in "Sector protection/unprotection".

12. Accelerated Program Operation

The device offers accelerated program operation which enables the programming in high speed. If the system asserts V_{ACC} to the \overline{WP}/ACC pin, the device automatically enters the acceleration mode and the time required for program operation will reduce to about 60%. This function is primarily intended to allow high speed program, so caution is needed as the sector group will temporarily be unprotected.

The system would use a fast program command sequence when programming during acceleration mode. Set command to fast mode and reset command from fast mode are not necessary. When the device enters the acceleration mode, the device automatically set to fast mode. Therefore, the pressent sequence could be used for programming and detection of completion during acceleration mode.

Removing Vacc from the WP/ACC pin returns the device to normal operation. Do not remove Vacc from WP/ACC pin while programming. See "17. Accelerated Program Timing Diagram" in ■TIMING DIAGRAM.

■ COMMAND DEFINITIONS

The device operations are selected by writing specific address and data sequences into the command register. Writing incorrect address and data values or writing them in the improper sequence will reset the device to the read mode. "MBM29LV320TE/BE Command Definitions Table" in ■DEVICE BUS OPERATIONS defines the valid register command sequences. Note that the Erase Suspend (B0h) and Erase Resume (30h) commands are valid only while the Sector Erase operation is in progress. Moreover both Read/Reset commands are functionally equivalent, resetting the device to the read mode. Please note that commands are always written at DQ7 to DQ0 and DQ15 to DQ8 bits are ignored.

1. Read/Reset Command

In order to return from Autoselect mode or Exceeded Timing Limits ($DQ_5 = 1$) to Read/Reset mode, the Read/Reset operation is initiated by writing the Read/Reset command sequence into the command register. Microprocessor read cycles retrieve array data from the memory. The device remain enabled for reads until the command register contents are altered.

The device will automatically power-up in the Read/Reset state. In this case, a command sequence is not required to read data. Standard microprocessor read cycles will retrieve array data. This default value ensures that no spurious alteration of the memory content occurs during the power transition. See "■AC CHARACTERISTICS" for the specific timing parameters.

2. Autoselect Command

Flash memories are intended for use in applications where the local CPU alters memory contents. As such, manufacture and device codes must be accessible while the device resides in the target system. PROM programmers typically access the signature codes by raising A_{θ} to a high voltage. However, multiplexing high voltage onto the address lines is not generally desired system design practice.

The device contains an Autoselect command operation to supplement traditional PROM programming methodology. The operation is initiated by writing the Autoselect command sequence into the command register.

Following the command write, a read cycle from address (XX) 00h retrieves the manufacture code of 04h. A read cycle from address (XX) 01h for ×16 ((XX) 02h for ×8) returns the device code. A read cycle from address (XX) 03h for ×16 ((XX) 06h for ×8) returns the extended device code. (See "MBM29LV320TE/BE Sector Group Protection Verify Autoselect Codes Table" and "Expanded Autoselect Code Table" in ■DEVICE BUS OPERATIONS.)

The sector state (protection or unprotection) will be informed by address (XX) 02h for $\times 16$ ((XX) 04h for $\times 8$). Scanning the sector group addresses (A₂₀, A₁₉, A₁₈, A₁₇, A₁₆, A₁₅, A₁₄, A₁₃, and A₁₂) while (A₆, A₁, A₀) = (0, 1, 0) will produce a logical "1" at device output DQ₀ for a protected sector group. The programming verification should be performed by verify sector group protection on the protected sector. (See "MBM29LV320TE/BE User Bus Operations Tables (BYTE = V_{IH} and BYTE = V_{IL})" in \blacksquare DEVICE BUS OPERATIONS.)

To terminate the operation, it is necessary to write the Read/Reset command sequence into the register. To execute the Autoselect command during the operation, writing Read/Reset command sequence must precede the Autoselect command.

3. Byte/Word Programming

The device is programmed on a byte-by-byte (or word-by-word) basis. Programming is a four bus cycle operation. There are two "unlock" write cycles. These are followed by the program set-up command and data write cycles. Addresses are latched on the falling edge of \overline{CE} or \overline{WE} , whichever happens later and the data is latched on the rising edge of \overline{CE} or \overline{WE} , whichever happens first. The rising edge of \overline{CE} or \overline{WE} (whichever happens first) begins programming. Upon executing the Embedded Program Algorithm command sequence, the system is not required to provide further controls or timings. The device will automatically provide adequate internally generated program pulses and verify the programmed cell margin.

The system can determine the status of the program operation by using DQ₇ (Data Polling), DQ₆ (Toggle Bit), or RY/BY. The Data Polling and Toggle Bit must be performed at the memory location which is being programmed.

The automatic programming operation is completed when the data on DQ_7 is equivalent to data written to this bit at which time the device return to the read mode and addresses are no longer latched. (See "Hardware Sequence Flags Table".) Therefore, the device requires that a valid address to the device be supplied by the system at this particular instance of time. Hence, \overline{Data} Polling must be performed at the memory location which is being programmed.

Any commands written to the chip during this period will be ignored. If hardware reset occurs during the programming operation, it is impossible to guarantee the data are being written.

Programming is allowed in any sequence and across sector boundaries. Beware that a data "0" cannot be programmed back to a "1". Attempting to do so may either hang up the device or result in an apparent success according to the data polling algorithm but a read from Read/Reset mode will show that the data is still "0". Only erase operations can convert "0"s to "1"s.

"1. Embedded Program™ Algorithm" in ■FLOW CHART illustrates the Embedded Program™ Algorithm using typical command strings and bus operations.

4. Chip Erase

Chip erase is a six bus cycle operation. There are two "unlock" write cycles. These are followed by writing the "set-up" command. Two more "unlock" write cycles are then followed by the chip erase command.

Chip erase does not require the user to program the device prior to erase. Upon executing the Embedded Erase Algorithm command sequence the device will automatically program and verify the entire memory for an all zero data pattern prior to electrical erase (Preprogram function) . The system is not required to provide any controls or timings during these operations.

The system can determine the status of the erase operation by using DQ_7 (\overline{Data} Polling), DQ_6 (Toggle Bit), or RY/ \overline{BY} . The chip erase begins on the rising edge of the last \overline{CE} or \overline{WE} , whichever happens first in the command sequence and terminates when the data on DQ_7 is "1" (See "12. Write Operation Status".) at which time the device returns to read the mode.

Chip Erase Time; Sector Erase Time × All sectors + Chip Program Time (Preprogramming)

"2. Embedded Erase™ Algorithm" in ■FLOW CHART illustrates the Embedded Erase™ Algorithm using typical command strings and bus operations.

5. Sector Erase

Sector erase is a six bus cycle operation. There are two "unlock" write cycles. These are followed by writing the "set-up" command. Two more "unlock" write cycles are then followed by the Sector Erase command. The sector address (any address location within the desired sector) is latched on the falling edge of \overline{CE} or \overline{WE} whichever happens later, while the command (Data = 30h) is latched on the rising edge of \overline{CE} or \overline{WE} which happens first. After time-out of "trow" from the rising edge of the last sector erase command, the sector erase operation will begin.

Multiple sectors may be erased concurrently by writing the six bus cycle operations on "MBM29LV320TE/BE Command Definitions Table" in \blacksquare DEVICE BUS OPERATIONS. This sequence is followed with writes of the Sector Erase command to addresses in other sectors desired to be concurrently erased. The time between writes must be less than "trow" otherwise that command will not be accepted and erasure will not start. It is recommended that processor interrupts be disabled during this time to guarantee this condition. The interrupts can be re-enabled after the last Sector Erase command is written. A time-out of "trow" from the rising edge of last $\overline{\text{CE}}$ or $\overline{\text{WE}}$ whichever happens first will initiate the execution of the Sector Erase command(s). If another falling edge of $\overline{\text{CE}}$ or $\overline{\text{WE}}$, whichever happens first occurs within the "trow" time-out window the timer is reset. (Monitor DQ3 to determine if the sector erase timer window is still open, see "16. DQ3", Sector Erase Timer.) Any command other than Sector Erase or Erase Suspend during this time-out period will reset the device to the read mode, ignoring the previous command string. Resetting the device once execution has begun will corrupt the data in the sector. In that case, restart the erase on those sectors and allow them to complete. (See "12. Write Operation Status" for Sector Erase Timer operation.) Loading the sector erase buffer may be done in any sequence and with any number of sectors (0 to 70).

Sector erase does not require the user to program the device prior to erase. The device automatically program all memory locations in the sector (s) to be erased prior to electrical erase (Preprogram function). When erasing

a sector or sectors the remaining unselected sectors are not affected. The system is not required to provide any controls or timings during these operations.

The system can determine the status of the erase operation by using DQ_7 (\overline{Data} Polling), DQ_6 (Toggle Bit), or RY/\overline{BY} .

The sector erase begins after the " t_{TOW} " time out from the rising edge of \overline{CE} or \overline{WE} whichever happens first for the last sector erase command pulse and terminates when the data on DQ_7 is "1" (See "12. Write Operation Status".) at which time the device return to the read mode. \overline{Data} polling and Toggle Bit must be performed at an address within any of the sectors being erased.

 $\label{eq:multiple Sector Erase Time} \ \ \text{Multiple Sector Erase Time} + \ \ \text{Sector Program Time} \ \ \ (\text{Preprogramming}) \] \times \ \ \text{Number of Sector Erase}$

"2. Embedded Erase™ Algorithm" in ■FLOW CHART illustrates the Embedded Erase™ Algorithm using typical command strings and bus operations.

6. Erase Suspend/Resume

The Erase Suspend command allows the user to interrupt a Sector Erase operation and then perform data reads from or programs to a sector not being erased. This command is applicable ONLY during the Sector Erase operation which includes the time-out period for sector erase. The Erase Suspend command will be ignored if written during the Chip Erase operation or Embedded Program Algorithm. Writting the Erase Suspend command (B0h) during the Sector Erase time-out results in immediate termination of the time-out period and suspension of the erase operation.

Writing the Erase Resume command (30h) resumes the erase operation. The addresses are "DON'T CARES" when writing the Erase Suspend or Erase Resume command.

When the Erase Suspend command is written during the Sector Erase operation, the device will take a maximum of "tspp" to suspend the erase operation. When the device has entered the erase-suspended mode, the

RY/ \overline{BY} output pin will be at Hi-Z and the DQ₇ bit will be at logic "1", and DQ₆ will stop toggling. The user must use the address of the erasing sector for reading DQ₆ and DQ₇ to determine if the erase operation has been suspended. Further writes of the Erase Suspend command are ignored.

When the erase operation has been suspended, the device defaults to the erase-suspend-read mode. Reading data in this mode is the same as reading from the standard read mode except that the data must be read from sectors that have not been erase-suspended. Successively reading from the erase-suspended sector while the device is in the erase-suspend-read mode will cause DQ₂ to toggle. (See "17. DQ₂".)

After entering the erase-suspend-read mode, the user can program the device by writing the appropriate command sequence for Program. This program mode is known as the erase-suspend-program mode. Again, programming in this mode is the same as programming in the regular Program mode except that the data must be programmed to sectors that are not erase-suspended. Successively reading from the erase-suspended sector while the device is in the erase-suspend-program mode will cause DQ_2 to toggle. The end of the erase-suspended Program operation is detected by the RY/\overline{BY} output pin, \overline{Data} polling of DQ_7 or by the Toggle Bit I (DQ_6) which is the same as the regular Program operation. Note that DQ_7 must be read from the Program address while DQ_6 can be read from any address.

To resume the operation of Sector Erase, the Resume command (30h) should be written. Any further writes of the Resume command at this point will be ignored. Another Erase Suspend command can be written after the chip has resumed erasing.

7. Extended Command

(1) Fast Mode

The device has Fast Mode function. This mode dispenses with the initial two unclock cycles required in the standard program command sequence by writing Fast Mode command into the command register. In this mode, the required bus cycle for programming is two cycles instead of four bus cycles in standard program command. (Do not write erase command in this mode.) The read operation is also executed after exiting this mode. To exit this mode, it is necessary to write Fast Mode Reset command into the command register. (See "8. Embedded ProgramTM Algorithm for Fast Mode" in \blacksquare FLOW CHART.) The Vcc active current is required even $\overline{CE} = V_{IH}$ during Fast Mode.

(2) Fast Programming

During Fast Mode, the programming can be executed with two bus cycles operation. The Embedded Program Algorithm is executed by writing program set-up command (A0h) and data write cycles (PA/PD) . (See "8. Embedded Program™ Algorithm for Fast Mode" in ■FLOW CHART.)

(3) CFI (Common Flash Memory Interface)

The CFI (Common Flash Memory Interface) specification outlines device and host system software interrogation handshake which allows specific vendor-specified software algorithms to be used for entire families of device. This allows device-independent, JEDEC ID-independent, and forward-and backward-compatible software support for the specified flash device families. See "Common Flash Memory Interface Code Table" in ■FLEXIBLE SECTOR-ERASE ARCHITECTURE for details.

The operation is initiated by writing the query command (98h) into the command register. Following the command write, a read cycle from specific address retrives device information. Please note that output data of upper byte (DQ₁₅ to DQ₃) is "0" in word mode (16 bit) read. See "Common Flash Memory Interface Code Table" in ■FLEXIBLE SECTOR-ERASE ARCHITECTURE. To terminate operation, it is necessary to write the read/reset command sequence into the register. (See "Common Flash Memory Interface Code Table" in ■FLEXIBLE SECTOR-ERASE ARCHITECTURE.)

8. Hidden ROM (Hi-ROM) Region

The Hi-ROM feature provides a Flash memory region that the system may access through a new command sequence. This is primarily intended for customers who wish to use an Electronic Serial Number (ESN) in the device with the ESN protected against modification. Once the Hi-ROM region is protected, any further modification of that region is impossible. This ensures the security of the ESN once the product is shipped to the field.

The Hi-ROM region is 256 bytes in length and is stored at the same address of the "outermost" 8 K byte boot sector. The MBM29LV320TE occupies the address of the byte mode 3FFFC0h to 3FFFFh (word mode 1FFFE0h to 1FFFFh) and the MBM29LV320BE type occupies the address of the byte mode 000000h to 000080h (word mode 000000h to 000040h). After the system has written the Enter Hi-ROM command sequence, the system may read the Hi-ROM region by using the addresses normally occupied by the boot sector. That is, the device sends all commands that would normally be sent to the boot sector to the Hi-ROM region. This mode of operation continues until the system issues the Exit Hi-ROM command sequence, or until power is removed from the device. On power-up, or following a hardware reset, the device reverts to sending commands to the boot sector.

9. Hidden ROM (Hi-ROM) Entry Command

The device has a Hidden ROM area with One Time Protect function. This area is to enter the security code and to unable the change of the code once set. Program/erase is possible in this area until it is protected. However, once it is protected, it is impossible to unprotect, so please use this with caution.

Hidden ROM area is 256 byte and in the same address area of "outermost" 8 K byte boot block. Therefore, write the Hidden ROM entry command sequence to enter the Hidden ROM area. It is called as Hidden ROM mode when the Hidden ROM area appears.

Sector other than the boot block area could be read during Hidden ROM mode. Read/program of the Hidden ROM area is possible during Hidden ROM mode. Write the Hidden ROM reset command sequence to exit the Hidden ROM mode.

10. Hidden ROM (Hi-ROM) Program Command

To program the data to the Hidden ROM area, write the Hidden ROM program command sequence during Hidden ROM mode. This command is the same as the program command in usual except to write the command during Hidden ROM mode. Therefore the detection of completion method is the same as in the past, using the DQ_7 data poling, DQ_6 toggle bit and RY/\overline{BY} pin. Need to pay attention to the address to be programmed. If the address other than the Hidden ROM area is selected to program, data of the address will be changed.

Please note that the sector erase command is prohibited during Hidden ROM mode. If the sector erase command is appeared in this mode, data of the address will be erased.

11. Hidden ROM (Hi-ROM) Protect Command

There are two methods to protect the Hidden ROM area. One is to write the sector group protect setup command (60h), set the sector address in the Hidden ROM area and $(A_6, A_1, A_0) = (0,1,0)$, and write the sector group protect command (60h) during the Hidden ROM mode. The same command sequence could be used because it is the same as the extension sector group protect in the past except that it is in the Hidden ROM mode and it does not apply high voltage to \overline{RESET} pin. Please see "9. Extended Sector Group Protection" in $\blacksquare FUNCTIONAL$ DESCRIPTION for details of extention sector group protect setting.

The other is to apply high voltage (V_{ID}) to A_{9} and \overline{OE} , set the sector address in the Hidden ROM area and (A_{6} , A_{1} , A_{0}) = (0,1,0), and apply the write pulse during the Hidden ROM mode. To verify the protect circuit, apply high voltage (V_{ID}) to A_{9} , specify (A_{6} , A_{1} , A_{0}) = (0,1,0) and the sector address in the Hidden ROM area, and read. When "1" appears on DQ₀, the protect setting is completed. "0" will appear on DQ₀ if it is not protected. Please apply write pulse agian. The same command sequence could be used for the above method because other than the Hidden ROM mode, it is the same as the sector group protect in the past. Please see "7. Sector Group Protection" in FUNCTIONAL DESCRIPTION for details of the sector group protect setting.

Other sector group will be effected if the address other than those for Hidden ROM area is selected for the sector group address, so please be carefull. Once it is protected, protection can not be cancelled, so please pay the closest attention.

12. Write Operation Status

Details in "Hardware Sequence Flags Table" are all the status flags that can be used to check the status of the device for current mode operation. During sector erase, the part provides the status flags automatically to the I/O ports. The information on DQ2 is address sensitive. This means that if an address from an erasing sector is consecutively read, then the DQ2 bit will toggle. However, DQ2 will not toggle if an address from a non-erasing sector is consecutively read. This allows users to determine which sectors are in erase.

Once erase suspend is entered, address sensitivity still applies. If the address of a non-erasing sector (that is, one available for read) is provided, then stored data can be read from the device. If the address of an erasing sector (that is, one unavailable for read) is applied, the device will output its status bits.

Hardware Sequence Flags Table

| | DQ ₇ | DQ ₆ | DQ ₅ | DQ₃ | DQ ₂ | | |
|-------------------------|----------------------------|-------------------------------------------------------|-----------------|--------|-----------------|------|----------|
| | Embedded P | rogram Algorithm | DQ ₇ | Toggle | 0 | 0 | 1 |
| | Embedded E | rase Algorithm | 0 | Toggle | 0 | 1 | Toggle * |
| In Progress | _ | Erase Suspend Read (Erase Suspended Sector) | 1 | 1 | 0 | 0 | Toggle |
| | Erase Suspended Mode | Erase Suspend Read (Non-Erase Suspended Sector) | Data | Data | Data | Data | Data |
| | | Erase Suspend Program (Non-Erase Suspended Sector) | ŪQ ₇ | Toggle | 0 | 0 | 1 * |
| | Embedded P | rogram Algorithm | DQ ₇ | Toggle | 1 | 0 | 1 |
| Exceeded Time Limits | Embedded E | rase Algorithm | 0 | Toggle | 1 | 1 | N/A |
| | Erase Suspended Mode | Erase Suspend Program (Non-Erase Suspended Sector) | ŪQ ₇ | Toggle | 1 | 0 | N/A |

^{*:} Successive reads from the erasing or erase-suspend sector will cause DQ2 to toggle. Reading from non-erase suspend sector address will indicate logic "1" at the DQ2 bit.

13. DQ7

Data Polling

The device features Data Polling as a method to indicate to the host that the Embedded Algorithms are in progress or completed. During the Embedded Program Algorithm an attempt to read the device will produce a complement of data last written to DQ₇. Upon completion of the Embedded Program Algorithm, an attempt to read device will produce true data last written to DQ₇. During the Embedded Erase Algorithm, an attempt to read device will produce a "0" at the DQ₇ output. Upon completion of the Embedded Erase Algorithm an attempt to read device will produce a "1" on DQ₇. The flowchart for Data Polling (DQ₇) is shown in "3. Data Polling Algorithm" (■FLOW CHART).

For programming, the Data Polling is valid after the rising edge of the fourth write pulse in the four write pulse sequence.

For chip erase and sector erase, the Data Polling is valid after the rising edge of the sixth write pulse in the six write pulse sequence. Data Polling must be performed at sector address within any of the sectors being erased, not a protected sectors. Otherwise, the status may be invalid.

Once the Embedded Algorithm operation is close to being completed, the device data pins (DQ_7) may change asynchronously while the output enable (\overline{OE}) is asserted low. This means that the device is driving status information on DQ_7 at one instant of time and then that byte's valid data at the next instant of time. Depending on when the system samples the DQ_7 output, it may read the status or valid data. Even if the device has completed the Embedded Algorithm operation and DQ_7 has a valid data, the data outputs on DQ_0 to DQ_6 may be still invalid. The valid data on DQ_0 to DQ_7 will be read on the successive read attempts.

The Data Polling feature is active only during the Embedded Programming Algorithm, Embedded Erase Algorithm, Erase Suspend mode or sector erase time-out. (See "Hardware Sequence Flags" Table.)

See "6. Data Polling during Embedded Algorithm Operation Timing Diagram" in ■TIMING DIAGRAM for the Data Polling timing specifications and diagrams.

14. DQ6

Toggle Bit I

The device also features the "Toggle Bit I" as a method to indicate to the host system that the Embedded Algorithms are in progress or completed.

During Embedded Program or Erase Algorithm cycle, successive attempts to read ($\overline{\text{CE}}$ or $\overline{\text{OE}}$ toggling) data from the device will results in DQ $_6$ toggling between one and zero. Once the Embedded Program or Erase Algorithm cycle is completed, DQ $_6$ will stop toggling and valid data will be read on the next successive attempts. During programming, the Toggle Bit I is valid after the rising edge of the fourth write pulse in the four write pulse sequence. For chip erase and sector erase, the Toggle Bit I is valid after the rising edge of the sixth write pulse in the six write pulse sequence. The Toggle Bit I is active during the sector time out.

In program operation, if the sector being written is protected, the toggle bit will toggle for about 1 μ s and then stop toggling with data unchanged. In erase operation, the device will erase all selected sectors except for ones that are protected. If all selected sectors are protected, chip will toggle the toggle bit for about 400 μ s and then drop back into read mode, having data unchanged.

Either CE or OE toggling will cause DQ6 to toggle.

See "7. Toggle Bit I during Embedded Algorithm Operation Timing Diagram" in ■TIMING DIAGRAM for the Toggle Bit I timing specifications and diagrams.

15. DQ₅

Exceeded Timing Limits

 DQ_5 will indicate if the program or erase time has exceeded the specified limits (internal pulse count) . Under these conditions DQ_5 will produce a "1". This is a failure condition which indicates that the program or erase cycle was not successfully completed. Data Polling is the only operating function of device under this condition. The \overline{CE} circuit will partially power down device under these conditions (to approximately 2 mA) . The \overline{OE} and

 $\overline{\text{WE}}$ pins will control the output disable functions as described in "MBM29LV320TE/BE User Bus Operations Tables ($\overline{\text{BYTE}} = V_{\text{H}}$ and $\overline{\text{BYTE}} = V_{\text{L}}$)" (\blacksquare DEVICE BUS OPERATIONS).

The DQ_5 failure condition may also appear if a user tries to program a non blank location without erasing. In this case the device locks out and never complete the Embedded Algorithm operation. Hence, the system never read valid data on DQ_7 bit and DQ_6 never stop toggling. Once the device has exceeded timing limits, the DQ_5 bit will indicate a "1." Please note that this is not a device failure condition since device was incorrectly used. If this occurs, reset device with command sequence.

16. DQ₃

Sector Erase Timer

After completion of the initial sector erase command sequence the sector erase time-out will begin. DQ3 will remain low until the time-out is completed. Data Polling and Toggle Bit are valid after the initial sector erase command sequence.

If \overline{Data} Polling or Toggle Bit I indicates device has been written with a valid erase command, DQ_3 may be used to determine if the sector erase timer window is still open. If DQ_3 is high ("1") the internally controlled erase cycle has begun; attempts to write subsequent commands to the device will be ignored until the erase operation is completed as indicated by \overline{Data} Polling or Toggle Bit I. If DQ_3 is low ("0"), the device will accept additional sector erase commands. To insure the command has been accepted, the system software should check the status of DQ_3 prior to and following each subsequent Sector Erase command. If DQ_3 were high on the second status check, the command may not have been accepted.

See "Hardware Sequence Flags Table".

17. DQ₂

Toggle Bit II

This toggle bit II, along with DQ6, can be used to determine whether the device is in the Embedded Erase Algorithm or in Erase Suspend.

Successive reads from the erasing sector will cause DQ_2 to toggle during the Embedded Erase Algorithm. If the device is in the erase-suspended-read mode, successive reads from the erase-suspended sector will cause DQ_2 to toggle. When the device is in the erase-suspended-program mode, successive reads from the byte address of the non-erase suspended sector will indicate a logic "1" at the DQ_2 bit.

 DQ_6 is different from DQ_2 in that DQ_6 toggles only when the standard program or Erase, or Erase Suspend Program operation is in progress. The behavior of these two status bits, along with that of DQ_7 , is summarized as follows:

For example, DQ₂ and DQ₆ can be used together to determine if the erase-suspend-read mode is in progress. (DQ₂ toggles while DQ₆ does not.) See also "Toggle Bit Status Table" and "8. DQ₂ vs DQ₆" in ■TIMING DIAGRAM.

Furthermore, DQ₂ can also be used to determine which sector is being erased. When the device is in the erase mode, DQ₂ toggles if this bit is read from an erasing sector.

18. Reading Toggle Bits DQ6/DQ2

Whenever the system initially begins reading toggle bit status, it must read DQ_7 to DQ_0 at least twice in a row to determine whether a toggle bit is toggling. Typically, a system would note and store the value of the toggle bit after the first read. After the second read, the system would compare the new value of the toggle bit with the first. If the toggle bit is not toggling, this indicates that the device has completed the program or erase operation. The system can read array data on DQ_7 to DQ_0 on the following read cycle.

However, if after the initial two read cycles, the system determines that the toggle bit is still toggling, the system also should note whether the value of DQ_5 is high (see "15. DQ_5 "). If it is the system should then determine again whether the toggle bit is toggling, since the toggle bit may have stopped toggling just as DQ_5 went high. If the toggle bit is no longer toggling, the device has successfully completed the program or erase operation. If it is still toggling, the device did not complete the operation successfully, and the system must write the reset command to return to reading array data.

The remaining scenario is that the system initially determines that the toggle bit is toggling and DQ $_5$ has not gone high. The system may continue to monitor the toggle bit and DQ $_5$ through successive read cycles, determining the status as described in the previous paragraph. Alternatively, it may choose to perform other system tasks. In this case, the system must start at the beginning of the algorithm when it returns to determine the status of the operation. (See "4. Toggle Bit Algorithm" in \blacksquare FLOW CHART.)

Toggle Bit Status Table

| Mode | DQ ₇ | DQ ₆ | DQ ₂ |
|------------------------------------------------|-----------------|-----------------|-----------------|
| Program | ŪQ ₇ | Toggle | 1 |
| Erase | 0 | Toggle | Toggle* |
| Erase-Suspend Read (Erase-Suspended Sector) | 1 | 1 | Toggle |
| Erase-Suspend Program | ŪQ ₇ | Toggle | 1* |

^{*:} Successive reads from the erasing or erase-suspend sector will cause DQ2 to toggle. Reading from non-erase suspend sector address will indicate logic "1" at the DQ2 bit.

19. RY/BY

Ready/Busy

The device provides a RY/BY open-drain output pin as a way to indicate to the host system that the Embedded Algorithms are either in progress or has been completed. If output is low, the device is busy with either a program or erase operation. If output is high, the device is ready to accept any read/write or erase operation. When the RY/BY pin is low, the device will not accept any additional program or erase commands. If the device is placed in an Erase Suspend mode, RY/BY output will be high.

During programming, RY/BY pin is driven low after the rising edge of the fourth write pulse. During an erase operation, RY/BY pin is driven low after the rising edge of the sixth write pulse. RY/BY pin will indicate a busy condition during RESET pulse. See "9. RY/BY Timing Diagram during Program/Erase operations" and "10. RESET, RY/BY Timing Diagram" in ■TIMING DIAGRAM for a detailed timing diagram. RY/BY pin is pulled high in standby mode.

Since this is an open-drain output, RY/BY pins can be tied together in parallel with a pull-up resistor to Vcc.

20. Byte/Word Configuration

BYTE pin selects byte (8-bit) mode or word (16-bit) mode for device. When this pin is driven high, the device operates in word (16-bit) mode. Data is read and programmed at DQ₁₅ to DQ₀. When this pin is driven low, the device operates in byte (8-bit) mode. Under this mode, DQ₁₅/A₁ pin becomes the lowest address bit, and DQ₁₄ to DQ₀ bits are tri-stated. However, the command bus cycle is always an 8-bit operation and hence commands are written at DQ₁₅ to DQ₀ and the DQ₂ to DQ₀ bits are ignored. See "11. Word Mode Configuration Timing Diagram", "12. Byte Mode Configuration Timing Diagram" and "13. BYTE Timing Diagram for Write Operations" in ■TIMING DIAGRAM the detail .

21. Data Protection

The device is designed to offer protection against accidental erasure or programming caused by spurious system level signals that may exist during power transitions. During power up device automatically resets internal state machine in Read mode. Also, with its control register architecture, alteration of memory contents only occurs after successful completion of specific multi-bus cycle command sequences.

The device also incorporates several features to prevent inadvertent write cycles resulting from Vcc power-up and power-down transitions or system noise.

22. Low Vcc Write Inhibit

To avoid initiation of a write cycle during $V_{\rm CC}$ power-up and power-down, a write cycle is locked out for $V_{\rm CC}$ less than $V_{\rm LKO}$ (Min) . If $V_{\rm CC} < V_{\rm LKO}$, the command register is disabled and all internal program/erase circuits are disabled. Under this condition the device will reset to the read mode. Subsequent writes will be ignored until the $V_{\rm CC}$ level is greater than $V_{\rm LKO}$. It is the users responsibility to ensure that the control pins are logically correct to prevent unintentional writes when $V_{\rm CC}$ is above $V_{\rm LKO}$ (Min) .

If Embedded Erase Algorithm is interrupted, there is possibility that the erasing sector (s) cannot be used.

23. Write Pulse "Glitch" Protection

Noise pulses of less than 3 ns (Typ) on \overline{OE} , \overline{CE} , or \overline{WE} will not initiate a write cycle.

24. Logical Inhibit

Writing is inhibited by holding any one of $\overline{OE} = V_{IL}$, $\overline{CE} = V_{IH}$, or $\overline{WE} = V_{IH}$. To initiate a write cycle \overline{CE} and \overline{WE} must be a logical zero while \overline{OE} is a logical one.

25. Power-Up Write Inhibit

Power-up of the device with $\overline{WE} = \overline{CE} = V_{IL}$ and $\overline{OE} = V_{IH}$ will not accept commands on the rising edge of \overline{WE} . The internal state machine is automatically reset to the read mode on power-up.

ABSOLUTE MAXIMUM RATINGS

| Parameter | Symbol | Rat | Unit | | |
|--------------------------------------------------------------------------------------|-----------|------------|-----------|-------|--|
| Farameter | Syllibol | Min | Max | Oille | |
| Storage Temperature | Tstg | -55 | +125 | °C | |
| Ambient Temperature with Power Applied | TA | -40 | +85 | °C | |
| Voltage with Respect to Ground All pins except A ₉ , OE, and RESET *1, *2 | VIN, VOUT | -0.5 | Vcc + 0.5 | V | |
| Power Supply Voltage *1 | Vcc | -0.5 | +4.0 | V | |
| A ₉ , $\overline{\text{OE}}$, and $\overline{\text{RESET}}$ *1, *3 | Vin | -0.5 | +13.0 | V | |
| WP/ACC *1, *4 | Vacc | -0.5 | +13.0 | V | |

- *1: Voltage is defined on the basis of Vss = GND = 0 V.
- *2 : Minimum DC voltage on input or I/O pins is -0.5 V. During voltage transitions, input or I/O pins may undershoot Vss to -2.0 V for periods of up to 20 ns. Maximum DC voltage on input or I/O pins is Vcc + 0.5 V. During voltage transitions, input or I/O pins may overshoot to Vcc + 2.0 V for periods of up to 20 ns.
- * 3: Minimum DC input voltage on A₉, \overline{OE} and \overline{RESET} pins is –0.5 V. During voltage transitions, A₉, \overline{OE} and \overline{RESET} pins may undershoot Vss to –2.0 V for periods of up to 20 ns. Voltage difference between input and supply voltage (V_{IN} V_{CC}) does not exceed +9.0 V.Maximum DC input voltage on A₉, \overline{OE} and \overline{RESET} pins is +13.0 V which may overshoot to +14.0 V for periods of up to 20 ns.
- * 4: Minimum DC input voltage on \overline{WP}/ACC pin is -0.5 V. During voltage transitions, \overline{WP}/ACC pin may undershoot Vss to -2.0 V for periods of up to 20 ns. Maximum DC input voltage on \overline{WP}/ACC pin is +13.0 V which may overshoot to +12.0 V for periods of up to 20 ns when Vcc is applied.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING RANGES

| Parameter | Symbol | Part No. | Va | Unit | | |
|----------------------|--------|--------------------------------|------|------|-------|--|
| Farameter | Symbol | Fait No. | Min | Max | Oilit | |
| Ambient Temperature | TA | MBM29LV320TE/BE 80/90/10 | -40 | +85 | °C | |
| Power Supply Voltage | Voc | Vcc MBM29LV320TE/BE 80/90 +3.0 | | +3.6 | V | |
| Fower Supply Voltage | VCC | MBM29LV320TE/BE 10 | +2.7 | +3.6 |] | |

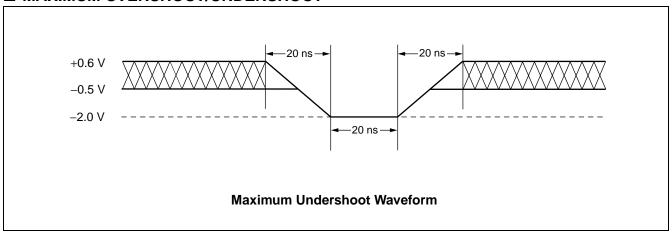
Operating ranges define those limits between which the functionality of the device is guaranteed.

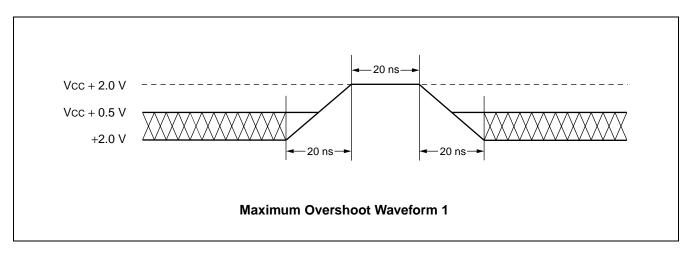
WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

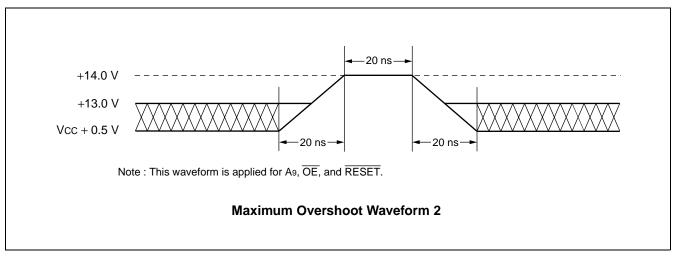
Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

■ MAXIMUM OVERSHOOT/UNDERSHOOT







■ DC CHARACTERISTICS

| Parameter | Symbol | Conditions | Min | Max | Unit | |
|------------------------------------------------------------------------------------------------------------|------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------|-------|-----------|------|
| Input Leakage Current | lu | VIN = Vss to Vcc, Vcc = Vcc M | -1.0 | +1.0 | μΑ | |
| Output Leakage Current | ILO | $V_{OUT} = V_{SS} \text{ to } V_{CC}, V_{CC} = V_{CC}$ | Max | -1.0 | +1.0 | μΑ |
| A ₉ , OE, RESET Inputs Leakage Current | Інт | Vcc = Vcc Max, A ₉ , OE , RESET = 12.5 V | | _ | 35 | μΑ |
| | | $\overline{CE} = V_{IL}, \overline{OE} = V_{IH},$ | Byte | | 16 | mA |
| Vcc Active Current *1 | laa | f = 5 MHz | Word | _ | 18 | IIIA |
| VCC Active Current | Icc1 | $\overline{CE} = V_{IL}, \overline{OE} = V_{IH},$ | Byte | | 7 | mA |
| | | f = 1 MHz | Word | _ | 7 | mA |
| Vcc Active Current *2 | Icc2 | $\overline{CE} = V_{IL}, \overline{OE} = V_{IH}$ | | _ | 40 | mA |
| Vcc Current (Standby) | Іссз | $Vcc = Vcc Max, \overline{CE} = Vcc \pm 0$ $\overline{RESET} = Vcc \pm 0.3 V$ | $V_{CC} = V_{CC} \text{ Max, } \overline{CE} = V_{CC} \pm 0.3 \text{ V,}$ $\overline{RESET} = V_{CC} \pm 0.3 \text{ V}$ | | 5 | μΑ |
| Vcc Current (Standby, Reset) | Icc4 | $Vcc = Vcc Max, \overline{WE}/ACC = Vco Max, \overline{WE}/ACC = V$ | _ | 5 | μΑ | |
| Vcc Current (Automatic Sleep Mode) *3 | Icc5 | | _ | 5 | μА | |
| WP/ACC Accelerated Program Current | Iacc | Vcc = Vcc Max, WP/ACC = Vacc Max | _ | 20 | mA | |
| Input Low Level | VIL | _ | | - 0.5 | + 0.6 | V |
| Input High Level | ViH | _ | | 2.0 | Vcc + 0.3 | V |
| Voltage for WP/ACC Sector Protection/Unprotection and Program Acceleration | Vacc | _ | | 11.5 | 12.5 | V |
| Voltage for Autoselect and Sector Group Protection (A ₉ , OE , RESET) *4 | VID | _ | 11.5 | 12.5 | V | |
| Output Low Voltage Level | Vol | IoL = 4.0 mA, Vcc = Vcc Min | _ | 0.45 | V | |
| Output High Voltage Level | V _{OH1} | Iон = −2.0 mA, Vcc = Vcc Mir | ı | 2.4 | _ | V |
| Output High Voltage Level | V _{OH2} | Іон = -100 μА | Vcc - 0.4 | _ | V | |
| Low Vcc Lock-Out Voltage | VLKO | | | 2.3 | 2.5 | V |

^{* 1:} The lcc current listed includes both the DC operating current and the frequency dependent component.

^{* 2:} lcc active while Embedded Algorithm (program or erase) is in progress.

^{* 3:} Automatic sleep mode enables the low power mode when addresses remain stable for 150 ns.

^{* 4:} Applicable for only Vcc applying.

■ AC CHARACTERISTICS

Read Only Operations Characteristics

| | Symbol | | | Value | | | | | | | |
|-------------------------------------------------------------------|---------------|----------------|------------------------------------------------------------|-------|-----|-----|-----|-----|-----|------|--|
| Parameter | JEDEC | Standard | Condi- tion | 80* | | 90* | | 10* | | Unit | |
| | JEDEC | Stariuaru | | Min | Max | Min | Max | Min | Max | | |
| Read Cycle Time | tavav | t RC | _ | 80 | | 90 | | 100 | | ns | |
| Address to Output Delay | tavqv | t ACC | <u>CE</u> = V _{IL} <u>OE</u> = V _{IL} | _ | 80 | _ | 90 | _ | 100 | ns | |
| Chip Enable to Output Delay | t ELQV | t ce | OE = VIL | _ | 80 | _ | 90 | _ | 100 | ns | |
| Output Enable to Output Delay | t GLQV | t oe | _ | _ | 30 | _ | 35 | _ | 35 | ns | |
| Chip Enable to Output High-Z | t ehqz | t DF | _ | _ | 25 | _ | 30 | _ | 30 | ns | |
| Output Enable to Output High-Z | t GHQZ | t DF | _ | _ | 25 | _ | 30 | | 30 | ns | |
| Output Hold Time From Addresses, CE or OE, Whichever Occurs First | taxqx | t oн | _ | 0 | | 0 | | 0 | _ | ns | |
| RESET Pin Low to Read Mode | | t READY | _ | | 20 | _ | 20 | | 20 | μs | |
| CE to BYTE Switching Low or High | | telfl telfh | _ | | 5 | _ | 5 | _ | 5 | ns | |

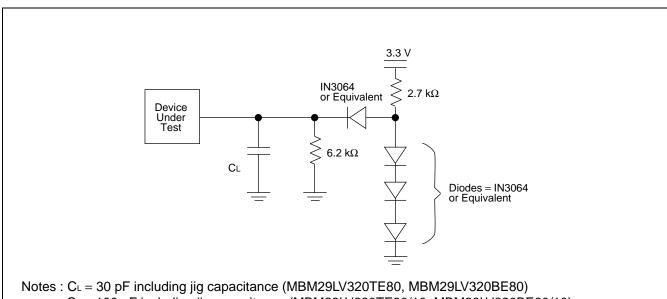
*: Test Conditions:

Output Load: 1 TTL gate and 30 pF (MBM29LV320TE80, MBM29LV320BE80)

100 pF (MBM29LV320TE90/10, MBM29LV320BE90/10)

Input rise and fall times: 5 ns Input pulse levels: 0.0 V or 3.0 V Timing measurement reference level

Input: 1.5 V Output: 1.5 V



C_L = 100 pF including jig capacitance (MBM29LV320TE90/10, MBM29LV320BE90/10)

Test Conditions

• Write/Erase/Program Operations

| | se/Program Oper | | Syr | mbol | | | | ١ | /alue | . | | | | |
|----------------------------------|-----------------------------|---------------|---------------|-------------------|--------------|-----|--------------|-----|-------|--------------|-----|-----|------|----|
| Parameter | | JEDEC | Standard | (| 80 (Note) | | 90 (Note) | | | 10 (Note) | | | Unit | |
| | | | | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | | |
| Write Cycle Tin | ne | | tavav | twc | 80 | | | 90 | - | _ | 100 | _ | _ | ns |
| Address Setup | Time | | t avwl | t as | 0 | | | 0 | | | 0 | | | ns |
| Address Hold T | Гime | | twlax | t ah | 45 | | | 45 | _ | | 45 | | | ns |
| Data Setup Tim | ne | | t dvwh | t DS | 30 | | | 35 | — | | 35 | | | ns |
| Data Hold Time | 9 | | twhox | t DH | 0 | | | 0 | _ | _ | 0 | _ | _ | ns |
| • | Read | | | | 0 | | | 0 | _ | _ | 0 | _ | _ | ns |
| able Hold Time | Toggle and Data | Polling | | t oeh | 10 | _ | _ | 10 | _ | _ | 10 | _ | _ | ns |
| Read Recover | Time Before Write | | t GHWL | t GHWL | 0 | | _ | 0 | _ | _ | 0 | | _ | ns |
| Read Recover (OE High to C | Time Before Write E Low) | 9 | t GHEL | t GHEL | 0 | | _ | 0 | | | 0 | | | ns |
| CE Setup Time |) | | t ELWL | t cs | 0 | | | 0 | _ | | 0 | | | ns |
| WE Setup Time | е | | twlel | tws | 0 | | | 0 | _ | | 0 | | | ns |
| CE Hold Time | | twheh | t cH | 0 | | _ | 0 | — | | 0 | | | ns | |
| WE Hold Time | | t EHWH | twн | 0 | | | 0 | _ | | 0 | | | ns | |
| Write Pulse Width | | twlwh | twp | 35 | _ | _ | 35 | _ | _ | 35 | _ | _ | ns | |
| CE Pulse Width | h | | t ELEH | t CP | 35 | _ | _ | 35 | _ | _ | 35 | _ | _ | ns |
| Write Pulse Wi | dth High | | twhwl | twpн | 25 | | | 30 | _ | | 30 | | | ns |
| CE Pulse Width | h High | | t ehel | t cph | 25 | _ | _ | 30 | _ | _ | 30 | _ | _ | ns |
| Drogramming (| Operation | Byte | twhwh1 | н1 t wнwн1 | | 8 | | | 8 | | _ | 8 | | μs |
| Programming (| operation | Word | | | _ | 16 | _ | _ | 16 | _ | _ | 16 | _ | μs |
| Sector Erase C | peration *1 | | twhwh2 | t whwh2 | _ | 1 | _ | _ | 1 | _ | _ | 1 | _ | S |
| Vcc Setup Time | Э | | _ | tvcs | 50 | | _ | 50 | _ | _ | 50 | | _ | μs |
| Rise Time to V | ID *2 | | _ | tvidr | 500 | _ | _ | 500 | _ | _ | 500 | _ | _ | ns |
| Rise Time to V _{ACC} *3 | | _ | tvaccr | 500 | | | 500 | _ | _ | 500 | | _ | ns | |
| Voltage Transition Time *2 | | | t∨LHT | 4 | _ | _ | 4 | _ | _ | 4 | _ | _ | μs | |
| Write Pulse Width *2 | | _ | twpp | 100 | _ | _ | 100 | _ | _ | 100 | _ | _ | μs | |
| OE Setup Time to WE Active *2 | | | toesp | 4 | — | | 4 | — | _ | 4 | — | _ | μs | |
| CE Setup Time to WE Active *2 | | | tcsp | 4 | _ | _ | 4 | — | _ | 4 | _ | _ | μs | |
| Recover Time | From RY/BY | | _ | t RB | 0 | _ | _ | 0 | — | | 0 | _ | | ns |
| RESET Pulse \ | Width | | _ | t RP | 500 | | _ | 500 | _ | _ | 500 | | _ | ns |
| RESET High Le | evel Period Before | Read | _ | t RH | 200 | _ | _ | 200 | _ | _ | 200 | _ | _ | ns |

(Continued)

(Continued)

| | Symbol | | Value | | | | | | | | | |
|----------------------------------------|--------|---------------|--------------|-----|--------------|-----|-----|--------------|-----|-----|------|----|
| Parameter | JEDEC | Standard | 80 (Note) | | 90 (Note) | | | 10 (Note) | | | Unit | |
| | | | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | |
| BYTE Switching Low to Output High-Z | _ | t FLQZ | _ | _ | 30 | | | 30 | | — | 30 | ns |
| BYTE Switching High to Output Active | _ | t FHQV | _ | _ | 80 | _ | _ | 90 | | _ | 100 | ns |
| Program/Erase Valid to RY/BY Delay | | t BUSY | _ | _ | 90 | _ | _ | 90 | | _ | 90 | ns |
| Delay Time from Embedded Output Enable | _ | t EOE | | | 80 | | | 90 | _ | | 100 | ns |
| Erase Time-out Time | _ | t TOW | 50 | _ | _ | 50 | | _ | 50 | _ | | μs |
| Erase Suspend Transition Time | _ | t spd | | | 20 | | | 20 | | | 20 | μs |

^{*1 :} This does not include the preprogramming time.

^{*2 :} This timing is for Sector Group Protection operation.

^{*3 :} This timing is limited for Accelerated Program operation only.

■ ERASE AND PROGRAMMING PERFORMANCE

| Parameter | | Limits | | Unit | Comments |
|-----------------------|-------------|--------|-------|----------|--------------------------------------------|
| raiailletei | Min Typ Max | | Oilit | Comments | |
| Sector Erase Time | | 1 | 10 | s | Excludes programming time prior to erasure |
| Word Programming Time | | 16 | 360 | μs | Excludes system-level over- |
| Byte Programming Time | _ | 8 | 300 | μs | head |
| Chip Programming Time | _ | _ | 100 | S | Excludes system-level over- head |
| Program/Erase Cycle | 100,000 | | | cycle | _ |

■ TSOP (I) PIN CAPACITANCE

| Parameter | Symbol | Condition | Val | Unit | |
|-------------------------|------------------|---------------------|------|------|-------|
| rarameter | Symbol | Condition | Тур | Max | Offic |
| Input Capacitance | Cin | V _{IN} = 0 | 6.0 | 7.5 | pF |
| Output Capacitance | Соит | Vout = 0 | 8.5 | 12.0 | pF |
| Control Pin Capacitance | C _{IN2} | V _{IN} = 0 | 8.0 | 10.0 | pF |
| WP/ACC Pin Capacitance | Сімз | V _{IN} = 0 | 15.0 | 20.0 | pF |

Note: Test conditions $T_A = +25$ °C, f = 1.0 MHz

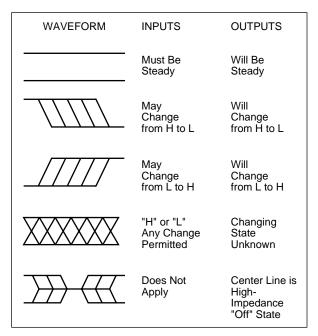
■ FBGA PIN CAPACITANCE

| Parameter | Symbol | Condition | Val | Unit | |
|-------------------------|------------------|---------------------|------|------|-------|
| raiailletei | Symbol | Condition | Тур | Max | Offic |
| Input Capacitance | Cin | V _{IN} = 0 | 6.0 | 7.5 | pF |
| Output Capacitance | Соит | Vоит = 0 | 8.5 | 12.0 | pF |
| Control Pin Capacitance | C _{IN2} | V _{IN} = 0 | 8.0 | 10.0 | pF |
| WP/ACC Pin Capacitance | Сімз | V _{IN} = 0 | 15.0 | 20.0 | pF |

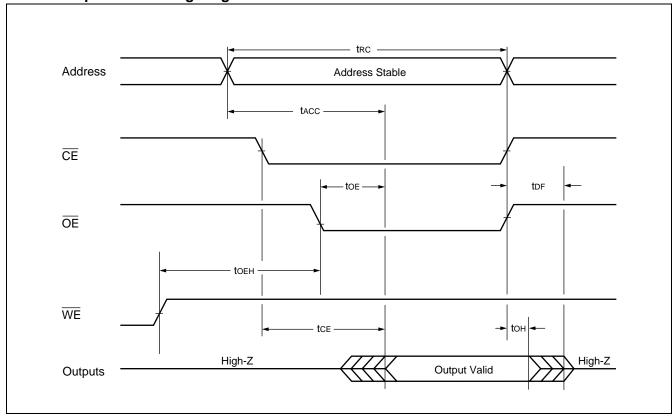
Note : Test conditions $T_A = +25$ °C, f = 1.0 MHz

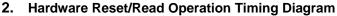
■ TIMING DIAGRAM

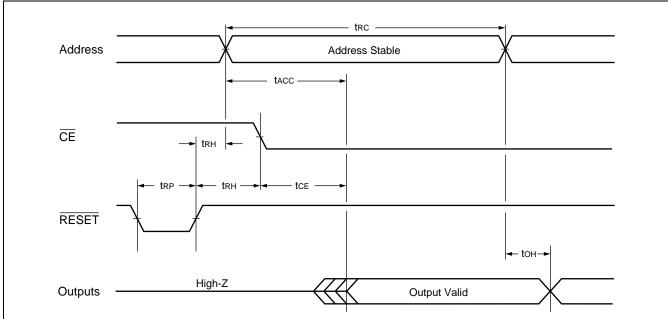
• Key to Switching Waveforms



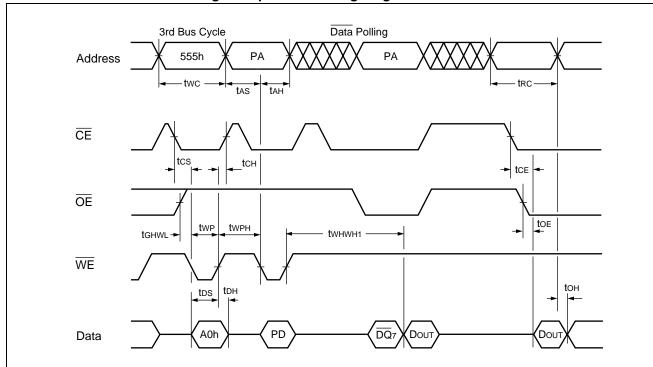
1. Read Operation Timing Diagram







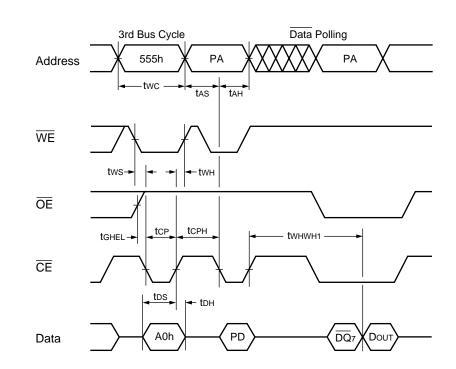
3. Alternate WE Controlled Program Operation Timing Diagram



Notes: • PA is address of the memory location to be programmed.

- PD is data to be programmed at byte address.
- $\overline{DQ_7}$ is the output of the complement of the data written to the device.
- Dout is the output of the data written to the device.
- Figure indicates last two bus cycles out of four bus cycle sequence.
- These waveforms are for the ×16 mode. (The addresses differ from ×8 mode.)

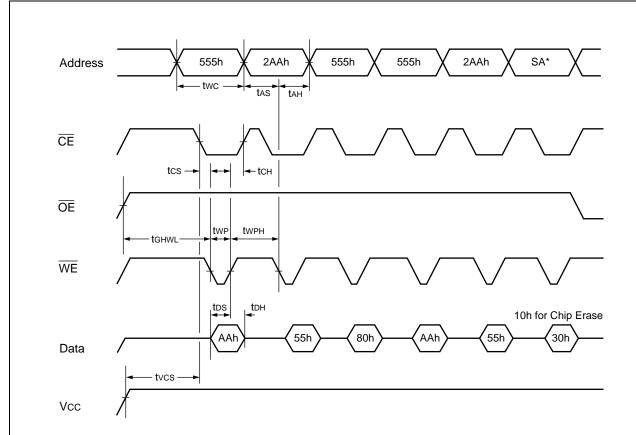
4. Alternate CE Controlled Program Operation Timing Diagram



Notes : • PA is address of the memory location to be programmed.

- PD is data to be programmed at byte address.
- $\overline{DQ_7}$ is the output of the complement of the data written to the device.
- Dout is the output of the data written to the device.
- Figure indicates last two bus cycles out of four bus cycle sequence.
- These waveforms are for the ×16 mode. (The addresses differ from ×8 mode.)

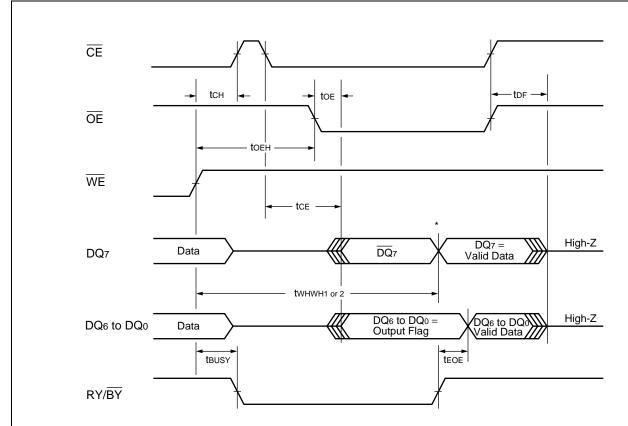
5. Chip/Sector Erase Operation Timing Diagram



*: SA is the sector address for Sector Erase. Addresses = 555h (Word), AAAh (Byte) for Chip Erase.

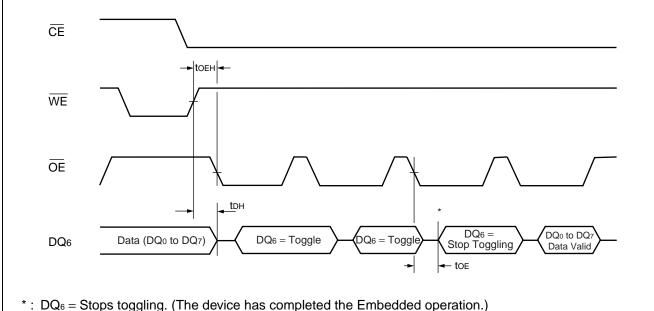
Note: These waveforms are for the ×16 mode. (The addresses differ from ×8 mode.)

6. Data Polling during Embedded Algorithm Operation Timing Diagram

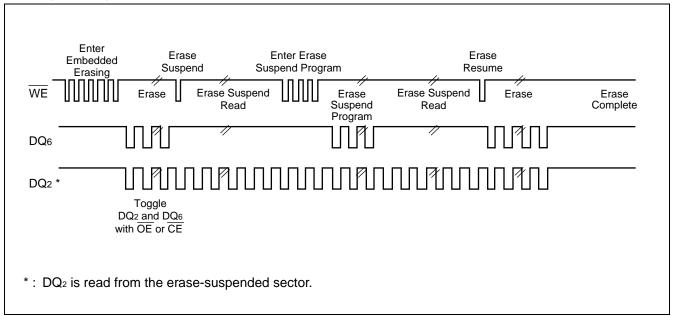


*: DQ7 = Valid Data (The device has completed the Embedded operation).

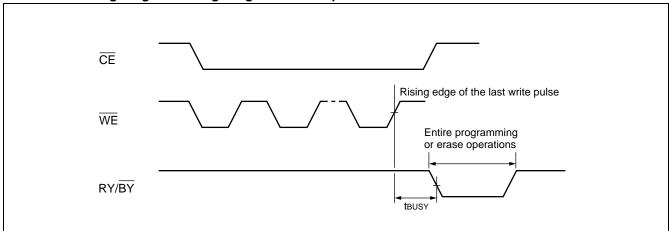
7. Toggle Bit I during Embedded Algorithm Operation Timing Diagram



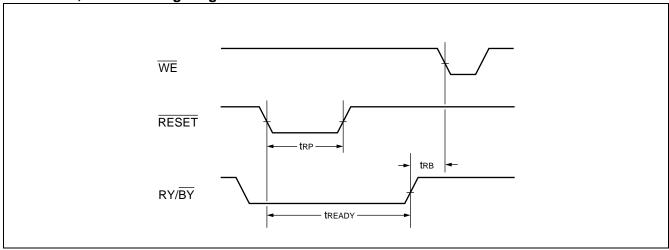
8. DQ₂ vs. DQ₆



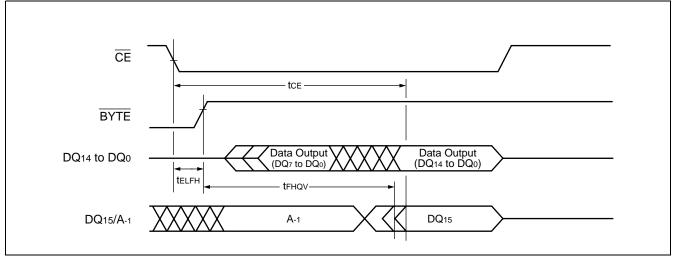
9. RY/BY Timing Diagram during Program/Erase Operations



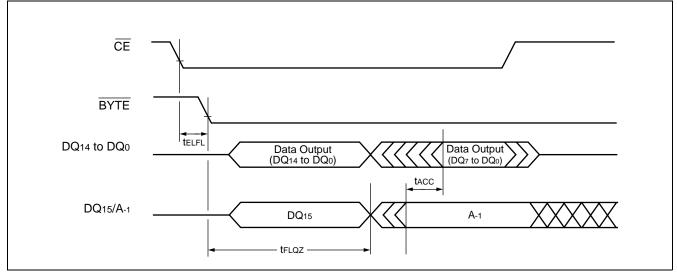




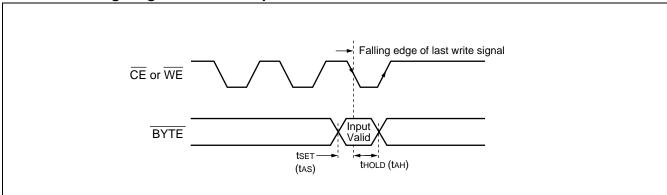
11. Word Mode Configuration Timing Diagram



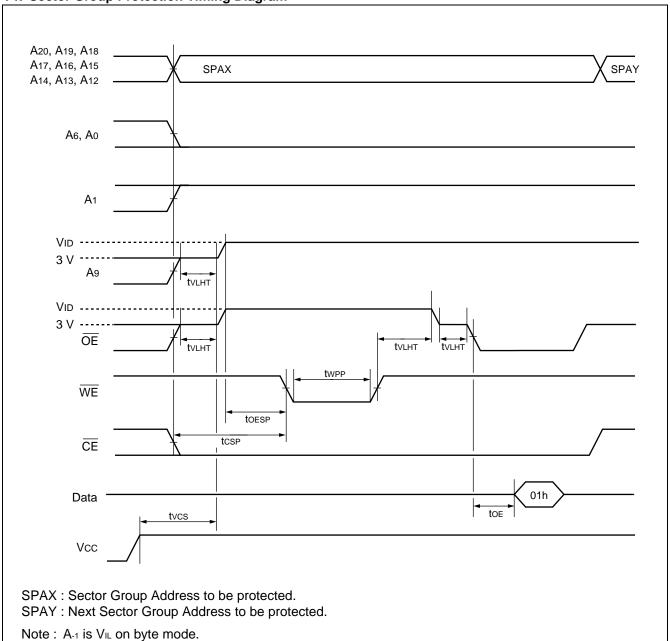
12. Byte Mode Configuration Timing Diagram

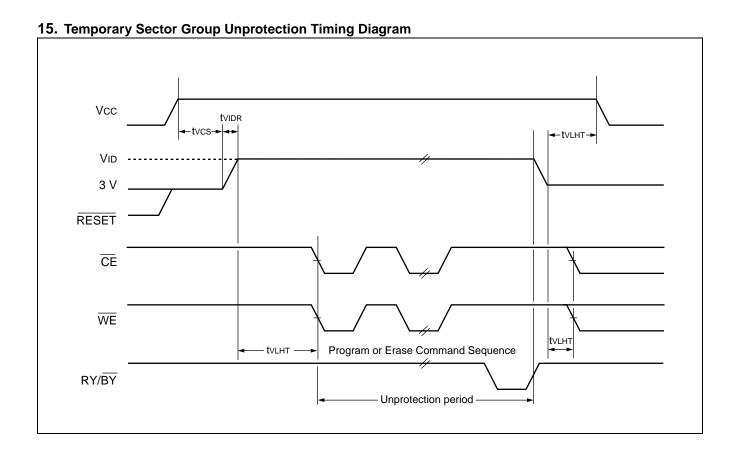


13. BYTE Timing Diagram for Write Operations

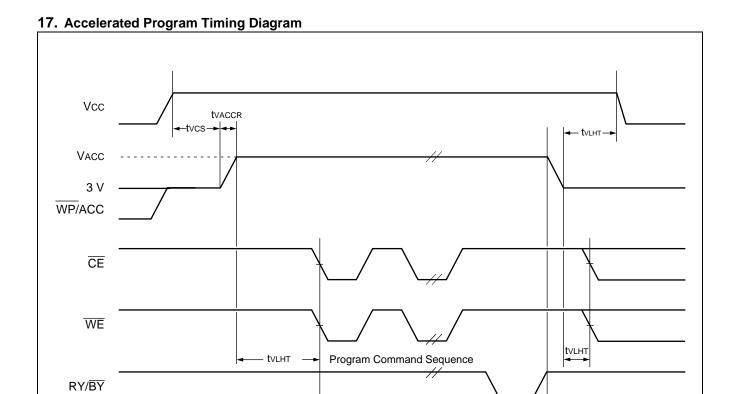


14. Sector Group Protection Timing Diagram





16. Extended Sector Group Protection Timing Diagram Vcc tvcs RESET t∨LHT - twc -Address **SPAX** SPAX **SPAY** A6, A0 **A**1 CE ŌĒ TIME-OUT twp $\overline{\mathsf{WE}}$ 60h 60h 40h Data 01h 60h toe SPAX : Sector Group Address to be protected SPAY: Next Sector Group Address to be protected TIME-OUT : Time-Out window = 250 μ s (Min)



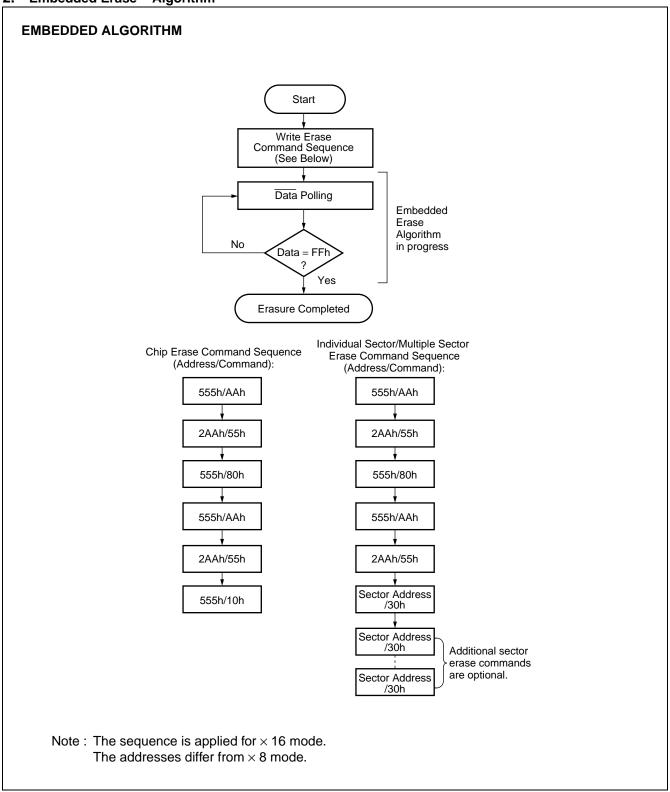
Acceleration period

■ FLOW CHART

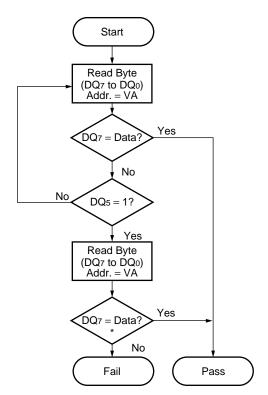
1. Embedded Program™ Algorithm

EMBEDDED ALGORITHM Start Write Program Command Sequence (See Below) Data Polling Embedded Program Algorithm in progress No Verify Data Yes No Increment Address Last Address Yes **Programming Completed** Program Command Sequence (Address/Command): 555h/AAh 2AAh/55h 555h/A0h Program Address/Program Data Note: The sequence is applied for \times 16 mode. The addresses differ from × 8 mode.

2. Embedded Erase™ Algorithm



3. Data Polling Algorithm

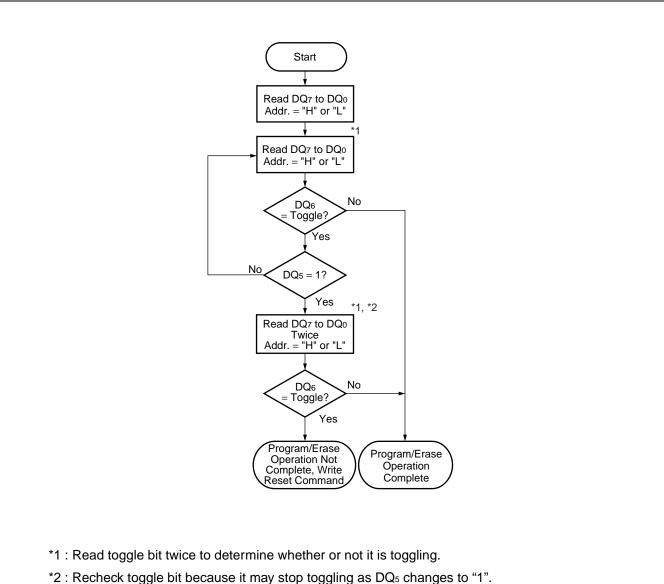


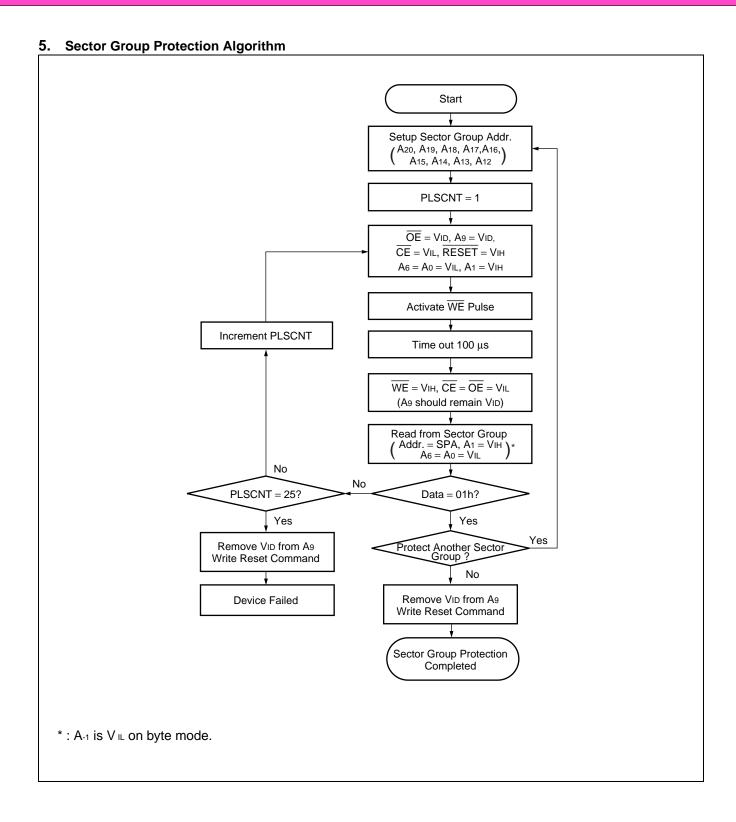
VA = Address for programming

- Any of the sector addresses within the sector being erased during sector erase or multiple erases operation
- Any of the sector addresses within the sector not being protected during sector erase or multiple sector erases operation

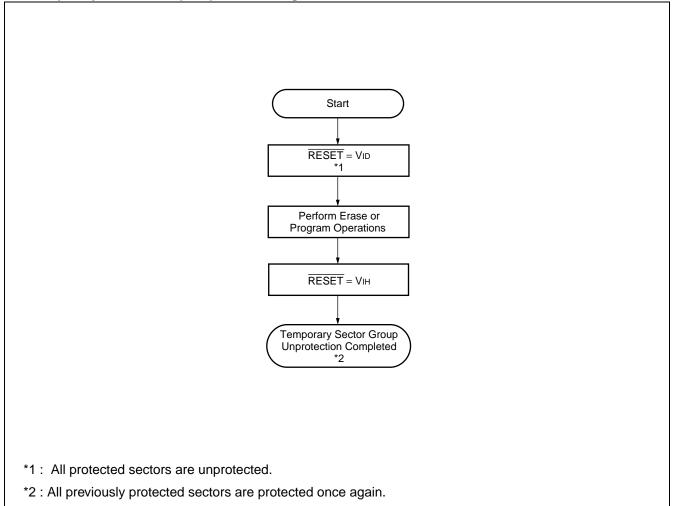
*: DQ7 is rechecked even if DQ5 = "1" because DQ7 may change simultaneously with DQ5.

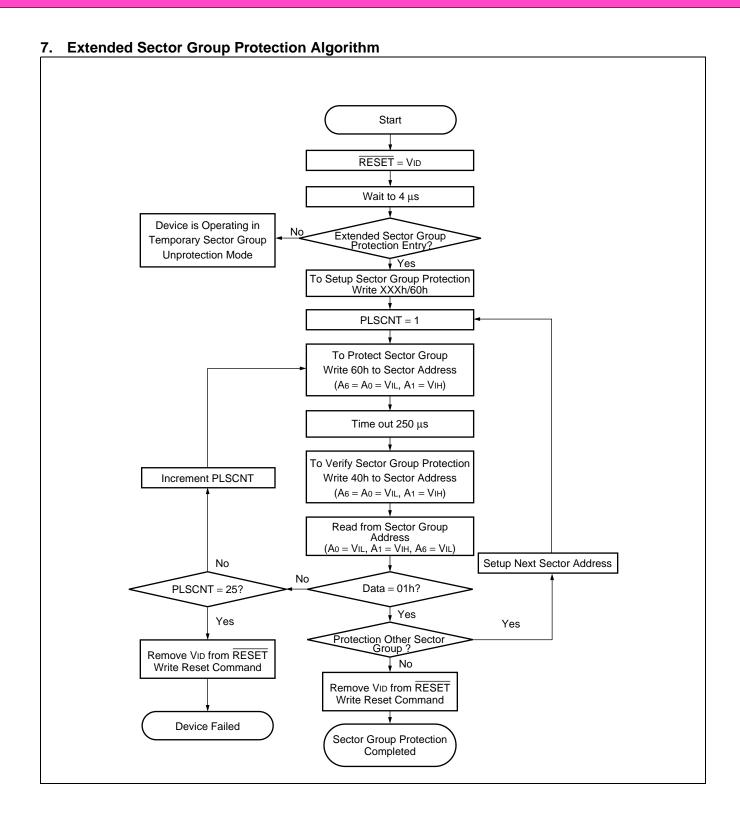
4. Toggle Bit Algorithm



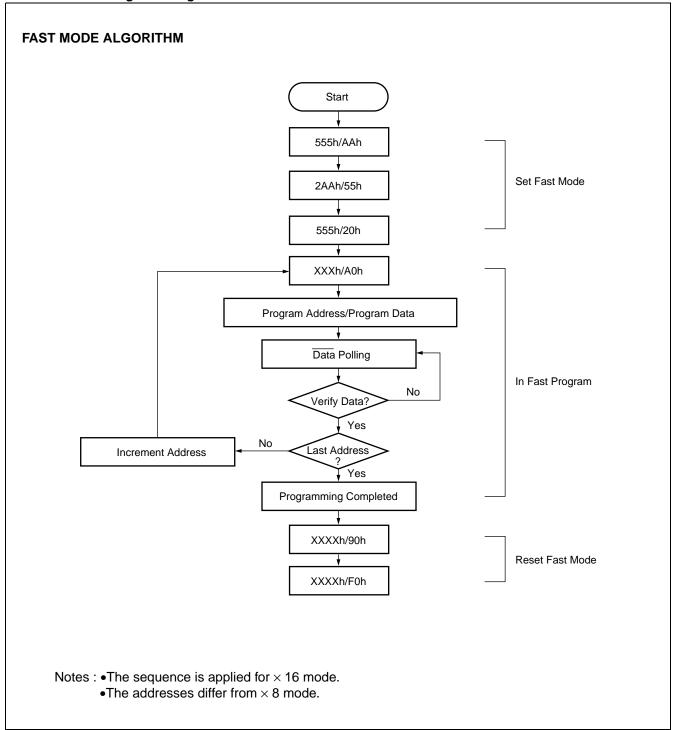


6. Temporary Sector Group Unprotection Algorithm





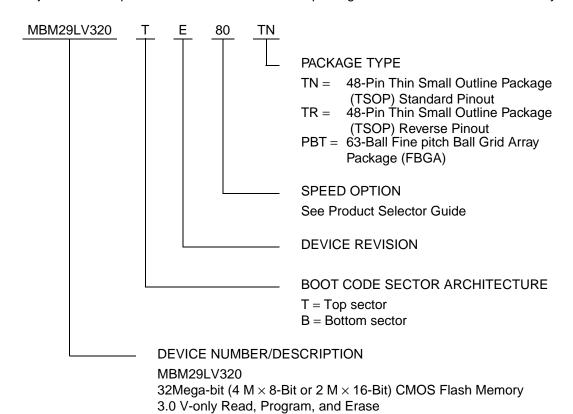
8. Embedded Program™ Algorithm for Fast Mode



■ ORDERING INFORMATION

Standard Products

Fujitsu standard products are available in several packages. The order number is formed by a combination of :

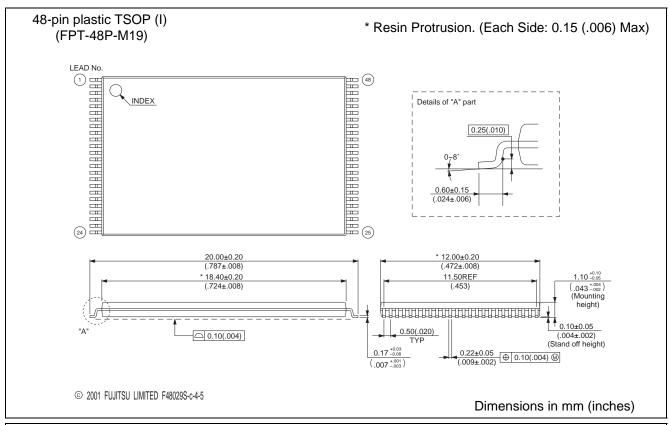


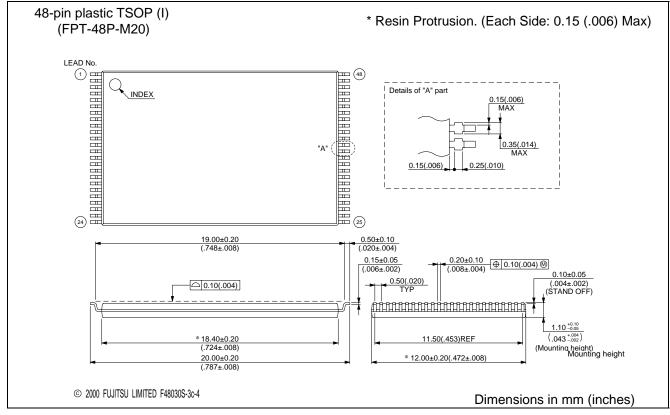
| Valid Combinations | | | | | | |
|--------------------|----|-----|--|--|--|--|
| | 80 | TN | | | | |
| MBM29LV320TE/BE | 90 | TR | | | | |
| | 10 | PBT | | | | |

Valid Combinations

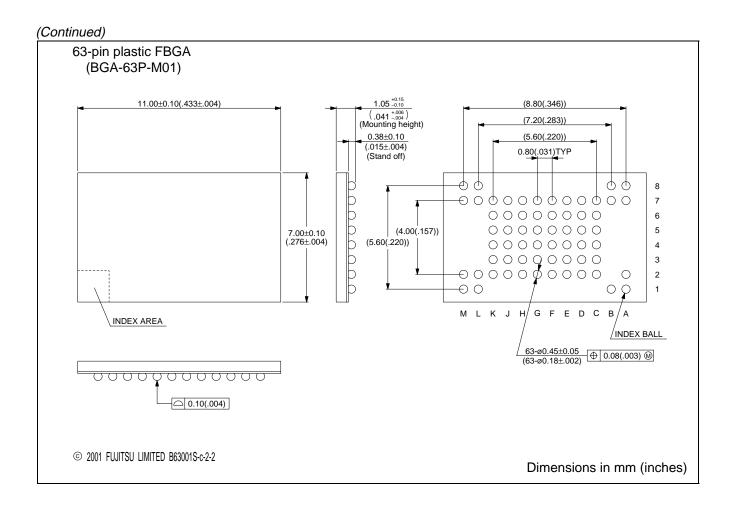
Valid Combinations list configurations planned to be supported in volume for this device. Consult the local Fujitsu sales office to confirm availability of specific valid combinations and to check on newly released combinations.

■ PACKAGE DIMENSION





(Continued)



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